S-1410/1411 Series

LOW CURRENT CONSUMPTION WATCHDOG TIMER WITH RESET FUNCTION

www.sii-ic.com

Rev.2.0_00

The S-1410/1411 Series is a watchdog timer developed using CMOS technology, which can operate with low current consumption of 3.8 μA typ. The reset function and the low voltage detection function are available.

■ Features

- Detection voltage: 2.0 V to 5.0 V, selectable in 0.1 V step
- Detection voltage accuracy: ±1.5%
- Input voltage: V_{DD} = 0.9 V to 6.0 V
- Hysteresis width: 5% typ.
- Current consumption: 3.8 μA typ.
- Reset time-out period: 14.5 ms typ. (C_{POR} = 2200 pF)
- Watchdog operation is switchable: Enable, Disable
- Watchdog operation voltage range: 2.5 V to 6.0 V
- Watchdog mode switching function*1: Time-out mode, window mode
- Watchdog input edge is selectable: Rising edge, falling edge, both rising and falling edges
- Product type is selectable: S-1410 Series
  (Product with $\overline{W}$ / T pin (Output: $\overline{WDO}$ pin))
  S-1411 Series
  (Product without $\overline{W}$ / T pin (Output: $\overline{RST}$ pin, $\overline{WDO}$ pin))
- Operation temperature range: Ta = −40°C to +105°C
- Lead-free (Sn 100%), halogen-free

***1.** The S-1411 Series is fixed to the window mode.

■ Applications

- Power supply monitoring of microcontroller mounted apparatus and system monitoring

■ Packages

- TMSOP-8
- HSNT-8(2030)

■ Block Diagrams

1. S-1410 Series (Product with $\overline{W}$ / T pin)

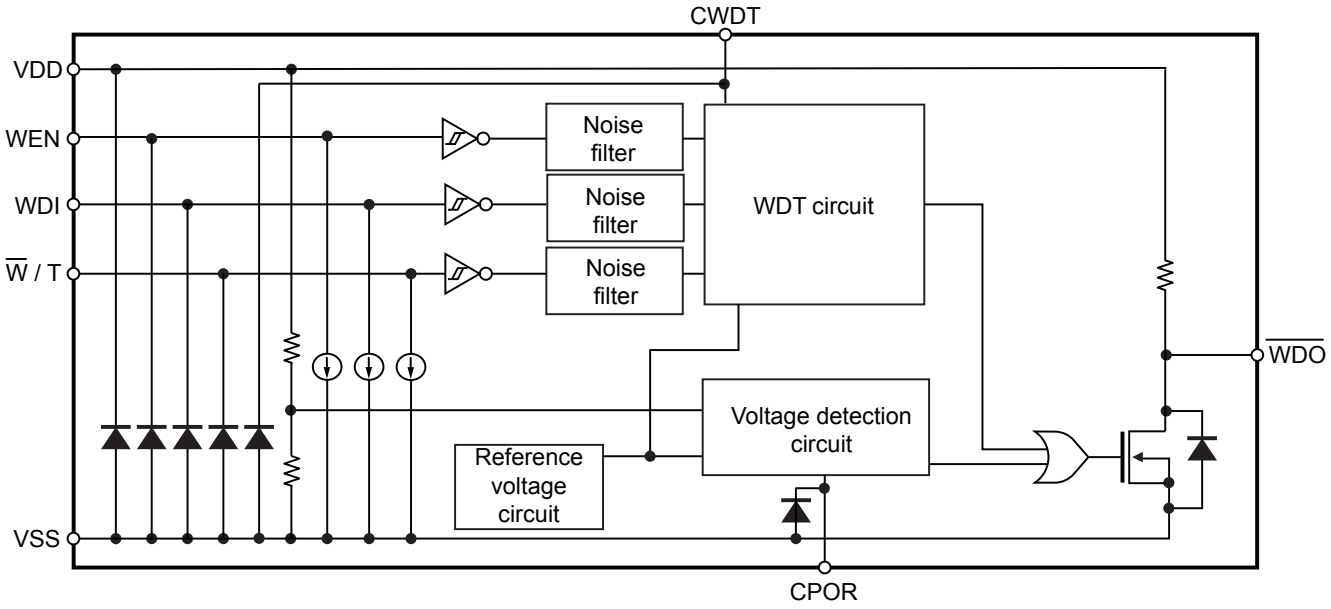


Figure 1

2. S-1411 Series (Product without $\overline{W}$ / T pin)

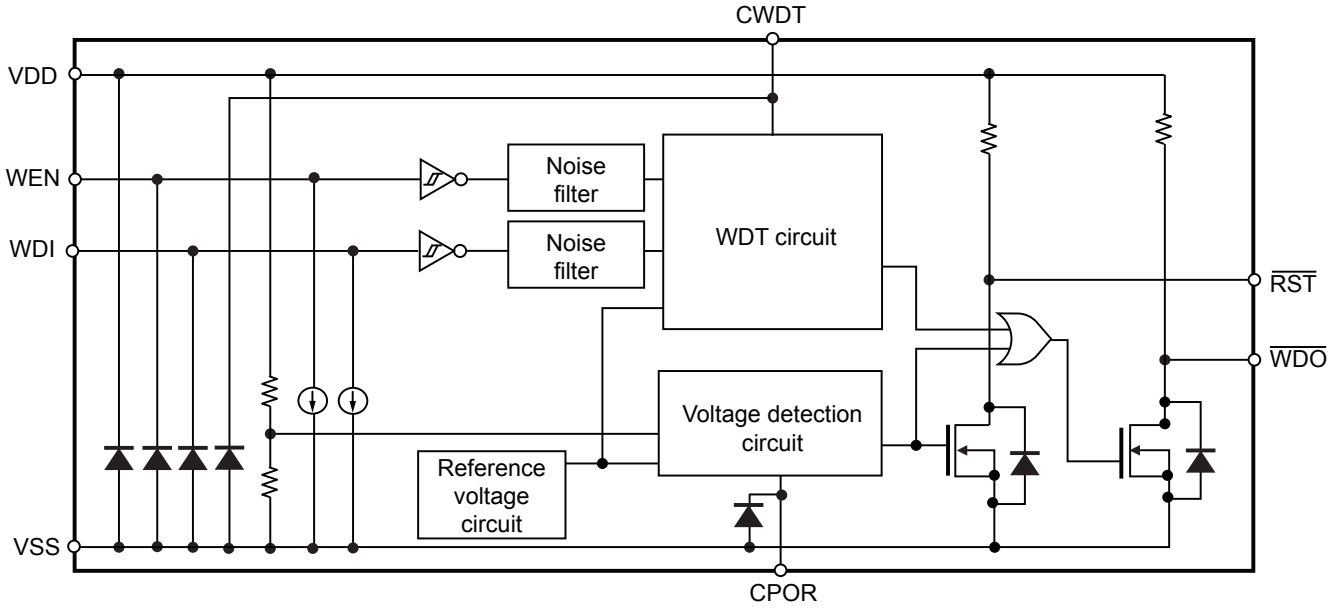


Figure 2

■ Product Name Structure

Users can select the product type, detection voltage, and package type for the S-1410/1411 Series. Refer to "**1. Product name**" regarding the contents of product name, "**2. Product type list**" regarding the product types, "**3. Packages**" regarding the package drawings.

1. Product name

S-141 x x xx - xxxx U 4

- Environmental code
  - U: Lead-free (Sn 100%), halogen-free
- Package abbreviation and IC packing specifications*1
  - K8T2: TMSOP-8, Tape
  - A8T1: HSNT-8(2030), Tape
- Detection voltage
  - 20 to 50
  - (e.g., when the detection voltage is 2.0 V, it is expressed as 20.)
- Product type 1*2
  - A to L
- Product type 2*3
  - 0, 1

***1.** Refer to the tape drawing.

***2.** Refer to "**2. Product type list**".

***3.** 0: S-1410 Series (Product with $\overline{W}$ / T pin)
The $\overline{WDO}$ pin outputs the signals which are from the watchdog timer circuit and the voltage detection circuit.
1: S-1411 Series (Product without $\overline{W}$ / T pin)
The $\overline{WDO}$ pin outputs the signals which are from the watchdog timer circuit and the voltage detection circuit.
The $\overline{RST}$ pin outputs the signal which is from the voltage detection circuit.
The watchdog mode is fixed to the window mode.

2. Product type list

Table 1

Product Type	WEN Pin Logic	Input Edge	Output Pull-up Resistor
A	Active "H"	Rising edge	Available
B	Active "H"	Falling edge	Available
C	Active "H"	Both rising and falling edges	Available
D	Active "L"	Rising edge	Available
E	Active "L"	Falling edge	Available
F	Active "L"	Both rising and falling edges	Available
G	Active "H"	Rising edge	Unavailable
H	Active "H"	Falling edge	Unavailable
I	Active "H"	Both rising and falling edges	Unavailable
J	Active "L"	Rising edge	Unavailable
K	Active "L"	Falling edge	Unavailable
L	Active "L"	Both rising and falling edges	Unavailable

3. Packages

Table 2 Package Drawing Codes

Package Name	Dimension	Tape	Reel	Land
TMSOP-8	FM008-A-P-SD	FM008-A-C-SD	FM008-A-R-SD	–
HSNT-8(2030)	PP008-A-P-SD	PP008-A-C-SD	PP008-A-R-SD	PP008-A-L-SD

■ Pin Configuration

1. TMSOP-8

Top view

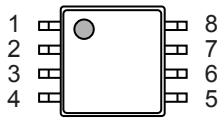


Figure 3

Table 3 S-1410 Series (Product with $\overline{W}$ / T pin)

Pin No.	Symbol	Description
1	$\overline{W}$ / T*1	Watchdog mode switching pin
2	CPOR	Reset time-out period adjustment pin
3	CWDT	Watchdog time adjustment pin
4	VSS	GND pin
5	WEN	Watchdog enable pin
6	$\overline{WDO}$	Watchdog output pin
7	WDI	Watchdog input pin
8	VDD	Voltage input pin

Table 4 S-1411 Series (Product without $\overline{W}$ / T pin)

Pin No.	Symbol	Description
1	$\overline{RST}$	Reset output pin
2	CPOR	Reset time-out period adjustment pin
3	CWDT	Watchdog time adjustment pin
4	VSS	GND pin
5	WEN	Watchdog enable pin
6	$\overline{WDO}$	Watchdog output pin
7	WDI	Watchdog input pin
8	VDD	Voltage input pin

***1.** $\overline{W}$ / T pin = "H": Time-out mode
$\overline{W}$ / T pin = "L": Window mode

2. HSNT-8(2030)

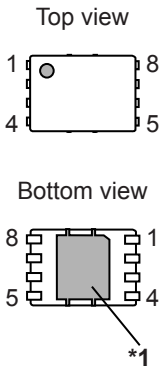


Figure 4

Table 5 S-1410 Series (Product with $\overline{W}$ / T pin)

Pin No.	Symbol	Description
1	$\overline{W}$ / T*2	Watchdog mode switching pin
2	CPOR	Reset time-out period adjustment pin
3	CWDT	Watchdog time adjustment pin
4	VSS	GND pin
5	WEN	Watchdog enable pin
6	$\overline{WDO}$	Watchdog output pin
7	WDI	Watchdog input pin
8	VDD	Voltage input pin

Table 6 S-1411 Series (Product without $\overline{W}$ / T pin)

Pin No.	Symbol	Description
1	$\overline{RST}$	Reset output pin
2	CPOR	Reset time-out period adjustment pin
3	CWDT	Watchdog time adjustment pin
4	VSS	GND pin
5	WEN	Watchdog enable pin
6	$\overline{WDO}$	Watchdog output pin
7	WDI	Watchdog input pin
8	VDD	Voltage input pin

***1.** Connect the heat sink of backside at shadowed area to the board, and set electric potential open or GND. However, do not use it as the function of electrode.

***2.** $\overline{W}$ / T pin = "H": Time-out mode
$\overline{W}$ / T pin = "L": Window mode

■ Pin Functions

Refer to "■ **Operation**" for details.

1. $\overline{W}$ / T pin (S-1410 Series only)

This is a pin to switch the watchdog mode.
The S-1410 Series changes to the time-out mode when the $\overline{W}$ / T pin is "H", and changes to the window mode when the $\overline{W}$ / T pin is "L". Switching the mode is prohibited during the operation.
The constant current source (0.3 μA typ.) is connected to the $\overline{W}$ / T pin, and it is pulled down internally.

1. 1 Time-out mode ($\overline{W}$ / T pin = "H")

The S-1410 Series detects an abnormality when not inputting an edge to the WDI pin during the watchdog time-out period (t_{WDU}). And then "L" is output from the $\overline{WDO}$ pin.

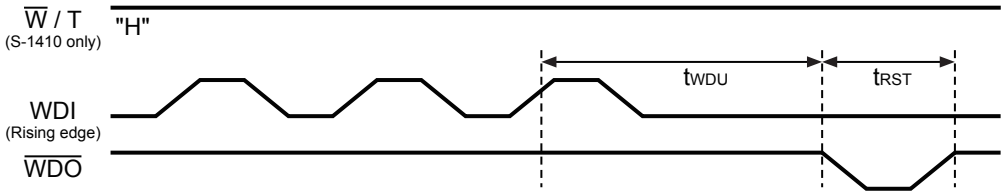


Figure 5 Abnormality Detection in Time-out Mode

1. 2 Window mode ($\overline{W}$ / T pin = "L")

When not inputting an edge to the WDI pin during t_{WDU}, or when an edge is input to the WDI pin again within a specific period of time (the discharge time due to an edge detection + 1 charge-discharge time (t_{WDL})) after inputting an edge to the WDI pin, the $\overline{WDO}$ pin output changes from "H" to "L".

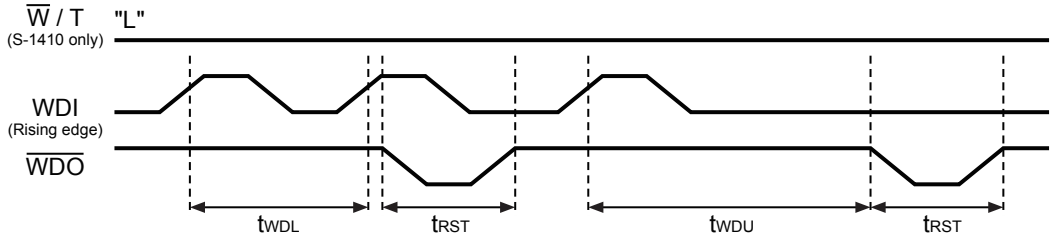


Figure 6 Abnormality Detection in Window Mode

2. $\overline{RST}$ pin (S-1411 Series only)

This is a reset output pin. It outputs "L" when detecting a low voltage.
Be sure to connect a pull-up resistor to the $\overline{RST}$ pin in the product without an output pull-up resistor.

3. CPOR pin

This is a pin to connect an external capacitor in order to generate the reset time-out period (t_{RST}).
The capacitor is charged and discharged by an internal constant current circuit, and the charge-discharge duration is t_{RST}.
t_{RST} is calculated by using the following equation.

$$t_{RST} = 6{,}500{,}000 \times C_{POR}\ [F] + 0.0002$$

4. CWDT pin

This is a pin to connect an external capacitor in order to generate the watchdog time-out period (t_{WDU}) and the watchdog double pulse detection time (t_{WDL}). The capacitor is charged and discharged by an internal constant current circuit.
t_{WDU} is calculated by using the following equation.

$$t_{WDU} = 50{,}000{,}000 \times C_{WDT}\ [F] + 0.0011$$

Moreover, t_{WDL} is calculated by using the following equation.

$$t_{WDL} = \frac{t_{WDU}}{32}$$

5. WEN pin

This is a pin to switch Enable / Disable of the watchdog timer.
When the WEN pin logic is active "H", the watchdog timer becomes Enable if the input is "H", and the charge-discharge operation is performed at the CWDT pin. In the active "H" product, the constant current source (0.3 μA typ.) is connected to the WEN pin, and it is pulled down internally.

6. $\overline{\text{WDO}}$ pin

This pin combines the reset output and the watchdog output.
Be sure to connect a pull-up resistor to the $\overline{\text{WDO}}$ pin in the product without an output pull-up resistor.

7. WDI pin

This is an input pin to receive a signal from the monitored object. By being input an edge at an appropriate timing, the WDI pin confirms the normal operation of the monitored object.
The constant current source (0.3 μA typ.) is connected to the WDI pin, and it is pulled down internally.

■ Absolute Maximum Ratings

Table 7

(Ta = +25°C unless otherwise specified)

Item		Symbol	Absolute Maximum Rating	Unit
VDD pin voltage		V_{DD}	V_{SS} – 0.3 to V_{SS} + 7.0	V
WDI pin voltage		V_{WDI}	V_{SS} – 0.3 to V_{DD} + 0.3 ≤ V_{SS} + 7.0	V
WEN pin voltage		V_{WEN}	V_{SS} – 0.3 to V_{DD} + 0.3 ≤ V_{SS} + 7.0	V
$\overline{W}$ / T pin voltage		$V_{\overline{W}/T}$	V_{SS} – 0.3 to V_{DD} + 0.3 ≤ V_{SS} + 7.0	V
CPOR pin voltage		V_{CPOR}	V_{SS} – 0.3 to V_{DD} + 0.3 ≤ V_{SS} + 7.0	V
CWDT pin voltage		V_{CWDT}	V_{SS} – 0.3 to V_{DD} + 0.3 ≤ V_{SS} + 7.0	V
$\overline{RST}$ pin voltage	A / B / C / D / E / F type	$V_{\overline{RST}}$	V_{SS} – 0.3 to V_{DD} + 0.3 ≤ V_{SS} + 7.0	V
	G / H / I / J / K / L type		V_{SS} – 0.3 to V_{SS} + 7.0	V
$\overline{WDO}$ pin voltage	A / B / C / D / E / F type	$V_{\overline{WDO}}$	V_{SS} – 0.3 to V_{DD} + 0.3 ≤ V_{SS} + 7.0	V
	G / H / I / J / K / L type		V_{SS} – 0.3 to V_{SS} + 7.0	V
Operation ambient temperature		T_{opr}	–40 to +105	°C
Storage temperature		T_{stg}	–40 to +150	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

■ Thermal Resistance Value

Table 8

Item	Symbol	Condition		Min.	Typ.	Max.	Unit
Junction-to-ambient thermal resistance*1	θ_{ja}	TMSOP-8	Board 1	–	160	–	°C/W
			Board 2	–	133	–	°C/W
		HSNT-8(2030)	Board 1	–	181	–	°C/W
			Board 2	–	135	–	°C/W

***1.** Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ **Thermal Characteristics**" for details of power dissipation and test board.

■ Electrical Characteristics

Table 9 (1 / 2)

(WEN pin logic active "H" product, V_{DD} = 5.0 V, Ta = +25°C unless otherwise specified)

Item	Symbol	Condition		Min.	Typ.	Max.	Unit	Test Circuit
Detection voltage*1	$-V_{DET}$	–		$-V_{DET(S)} \times 0.985$	$-V_{DET(S)}$	$-V_{DET(S)} \times 1.015$	V	1
Hysteresis width	V_{HYS}	–		$-V_{DET} \times 0.03$	$-V_{DET} \times 0.05$	$-V_{DET} \times 0.07$	V	1
Current consumption during operation	I_{SS1}	When watchdog timer operates		–	3.8	7.8	μA	2
Reset time-out period	t_{RST}	C_{POR} = 2200 pF		8.7	14.5	20	ms	3
Watchdog time-out period	t_{WDU}	C_{WDT} = 470 pF		15	24.6	34	ms	3
Watchdog double pulse detection time	t_{WDL}	C_{WDT} = 470 pF		461	769	1077	μs	4
Reset output voltage "H"	V_{ROH}	S-1411 Series A / B / C / D / E / F type only		V_{DD} – 1.0	–	–	V	5
Reset output voltage "L"	V_{ROL}	–		–	–	0.4	V	6
Reset output pull-up current	I_{RUP}	$V_{\overline{RST}}$ = 0 V, S-1411 Series A / B / C / D / E / F type only		–	–0.85	–0.4	μA	7
Reset output current	I_{ROUT}	V_{DS} = 0.4 V, S-1411 Series only	V_{DD} = 1.5 V	0.6	1.1	–	mA	8
			V_{DD} = 1.8 V	1.1	1.6	–	mA	8
			V_{DD} = 2.5 V	2.1	2.6	–	mA	8
			V_{DD} = 3.0 V	2.8	3.3	–	mA	8
Reset output leakage current	I_{RLEAK}	V_{DS} = 6.0 V, V_{DD} = 6.0 V, S-1411 Series only		–	–	0.096	μA	9
Watchdog output voltage "H"	V_{WOH}	A / B / C / D / E / F type only		V_{DD} – 1.0	–	–	V	10
Watchdog output voltage "L"	V_{WOL}	–		–	–	0.4	V	11
Watchdog output pull-up current	I_{WUP}	$V_{\overline{WDO}}$ = 0 V, A / B / C / D / E / F type only		–	–0.85	–0.4	μA	12
Watchdog output current	I_{WOUT}	V_{DS} = 0.4 V	V_{DD} = 1.5 V	0.6	1.1	–	mA	13
			V_{DD} = 1.8 V	1.1	1.6	–	mA	13
			V_{DD} = 2.5 V	2.1	2.6	–	mA	13
			V_{DD} = 3.0 V	2.8	3.3	–	mA	13
Watchdog output leakage current	I_{WLEAK}	V_{DS} = 6.0 V, V_{DD} = 6.0 V		–	–	0.096	μA	14
Input pin voltage 1 "H"	V_{SH1}	WEN pin		$0.7 \times V_{DD}$	–	–	V	15
Input pin voltage 1 "L"	V_{SL1}	WEN pin		–	–	$0.3 \times V_{DD}$	V	15
Input pin voltage 2 "H"	V_{SH2}	$\overline{W}$ / T pin, S-1410 Series only		$0.7 \times V_{DD}$	–	–	V	15
Input pin voltage 2 "L"	V_{SL2}	$\overline{W}$ / T pin, S-1410 Series only		–	–	$0.3 \times V_{DD}$	V	15
Input pin voltage 3 "H"	V_{SH3}	WDI pin		$0.7 \times V_{DD}$	–	–	V	15
Input pin voltage 3 "L"	V_{SL3}	WDI pin		–	–	$0.3 \times V_{DD}$	V	15

Table 9 (2 / 2)

(WEN pin logic active "H" product, V_{DD} = 5.0 V, Ta = +25°C unless otherwise specified)

Item	Symbol	Condition		Min.	Typ.	Max.	Unit	Test Circuit
Input pin current 1 "H"	I_{SH1}	WEN pin, V_{DD} = 6.0 V, Input pin voltage = 6.0 V	A / B / C / G / H / I type	–	0.3	1.0	µA	15
			D / E / F / J / K / L type	–0.1	–	0.1	µA	15
Input pin current 1 "L"	I_{SL1}	WEN pin, V_{DD} = 6.0 V, Input pin voltage = 0 V		–0.1	–	0.1	µA	15
Input pin current 2 "H"	I_{SH2}	$\overline{W}$ / T pin, S-1410 Series only, V_{DD} = 6.0 V, Input pin voltage = 6.0 V		–	0.3	1.0	µA	15
Input pin current 2 "L"	I_{SL2}	$\overline{W}$ / T pin, S-1410 Series only, V_{DD} = 6.0 V, Input pin voltage = 0 V		–0.1	–	0.1	µA	15
Input pin current 3 "H"	I_{SH3}	WDI pin, V_{DD} = 6.0 V, Input pin voltage = 6.0 V		–	0.3	1.0	µA	15
Input pin current 3 "L"	I_{SL3}	WDI pin, V_{DD} = 6.0 V, Input pin voltage = 0 V		–0.1	–	0.1	µA	15
Input pulse width "H"*2	t_{high1}	–		1.5	–	–	µs	15
Input pulse width "L"*2	t_{low1}	–		1.5	–	–	µs	15
Watchdog output delay time	t_{WOUT}	–		–	25	40	µs	3
Reset output delay time	t_{ROUT}	–		–	25	40	µs	3
Input setup time	t_{iset}	–		1.0	–	–	µs	3

***1.** $-V_{DET}$: Actual detection voltage, $-V_{DET(S)}$: Set detection voltage

***2.** The input pulse width "H" (t_{high1}) and the input pulse width "L" (t_{low1}) are defined as shown in **Figure 7**.
Inputs to the WEN pin and the WDI pin should be greater than or equal to the min. value specified in "■ **Electrical Characteristics**".

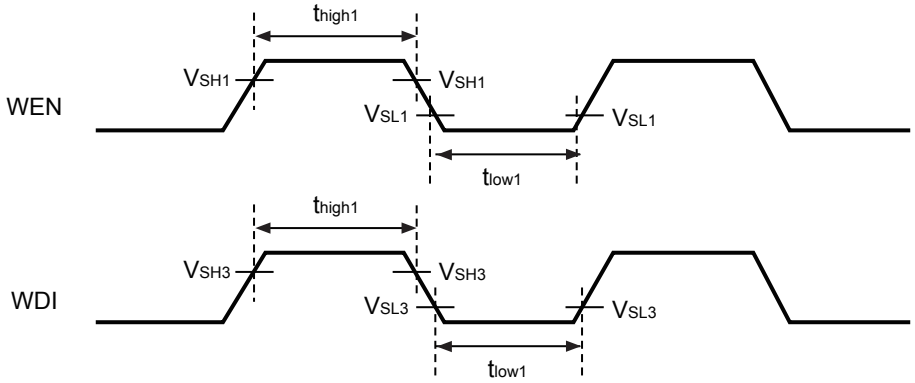


Figure 7

■ Test Circuits

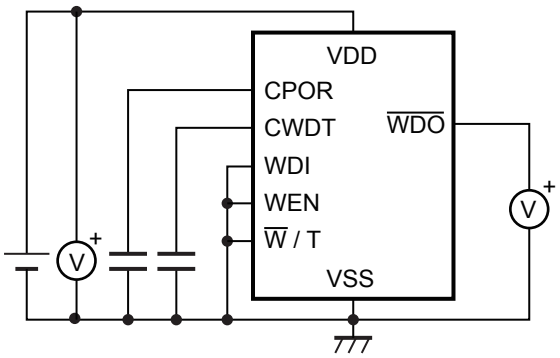


Figure 8 Test Circuit 1

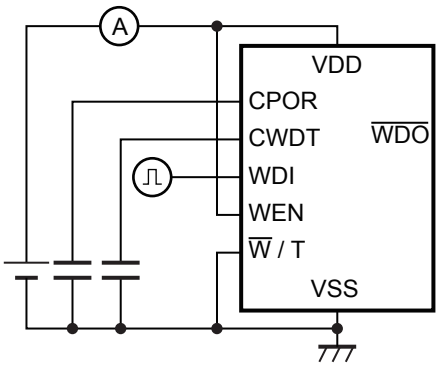


Figure 9 Test Circuit 2

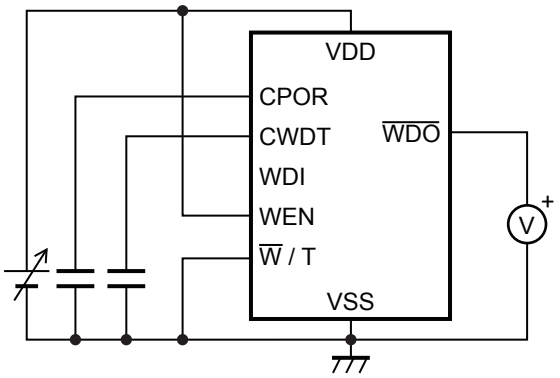


Figure 10 Test Circuit 3

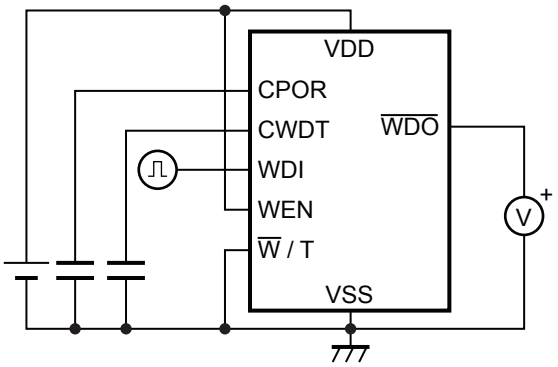


Figure 11 Test Circuit 4

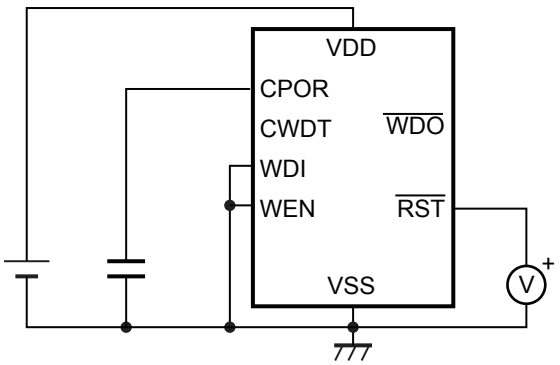


Figure 12 Test Circuit 5

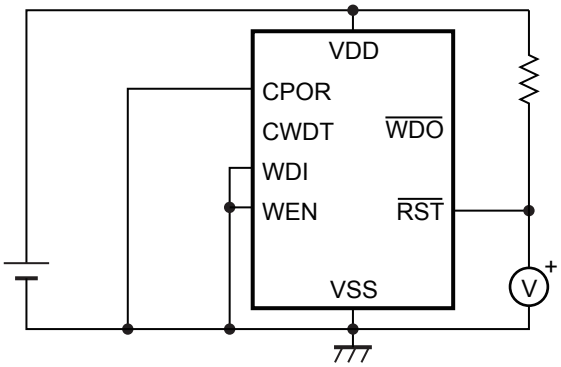


Figure 13 Test Circuit 6

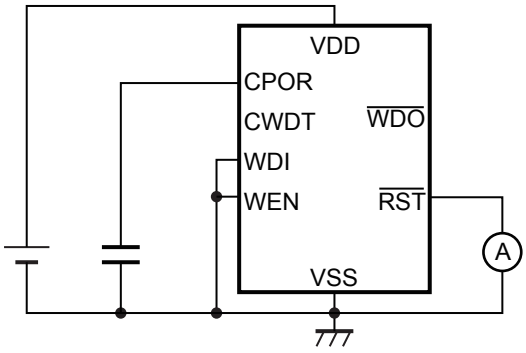


Figure 14 Test Circuit 7

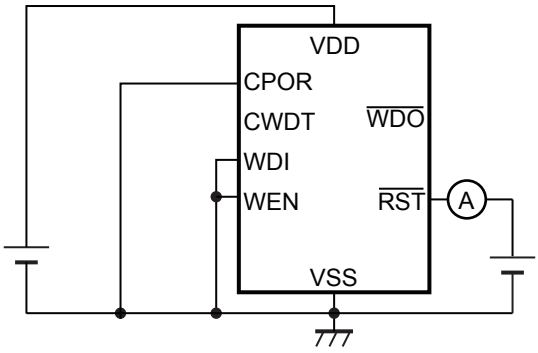


Figure 15 Test Circuit 8

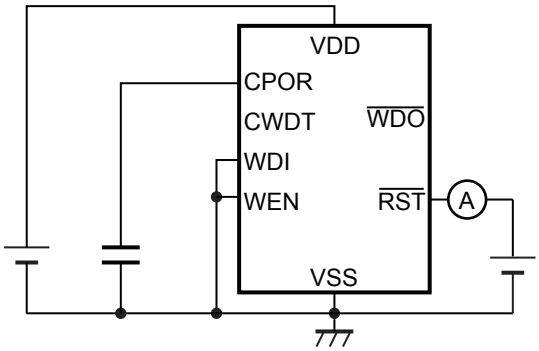


Figure 16 Test Circuit 9

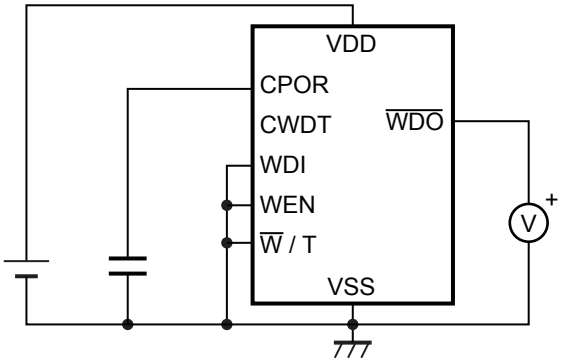


Figure 17 Test Circuit 10

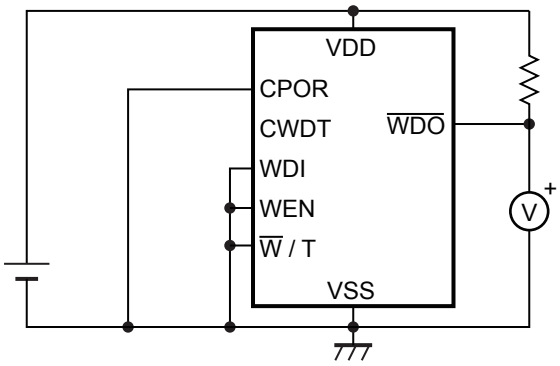


Figure 18 Test Circuit 11

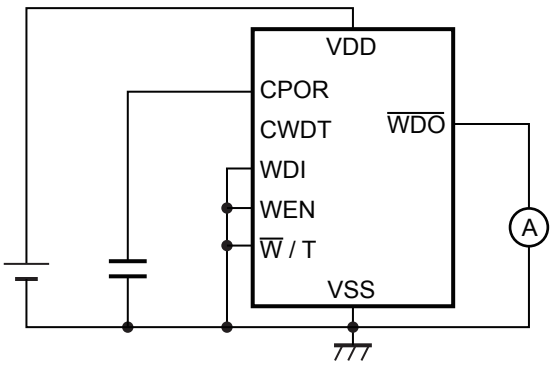


Figure 19 Test Circuit 12

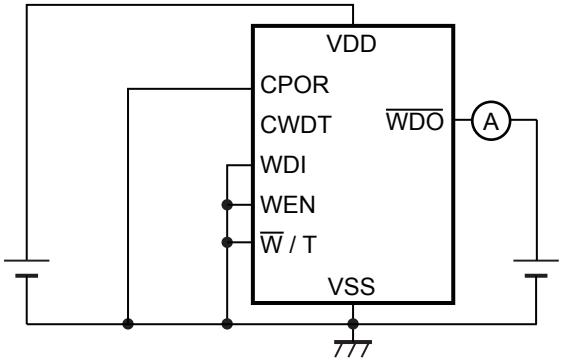


Figure 20 Test Circuit 13

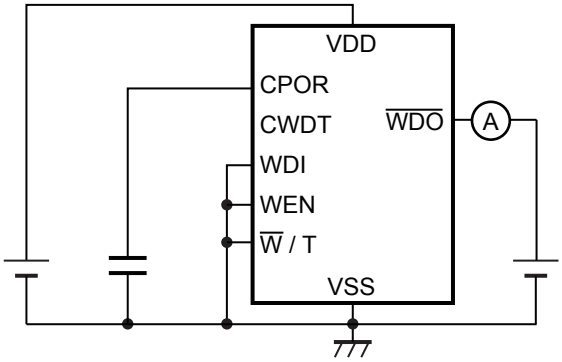


Figure 21 Test Circuit 14

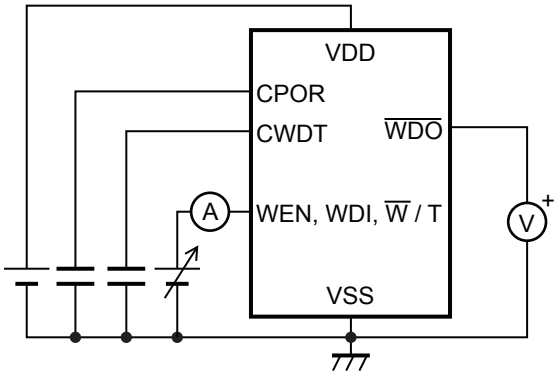
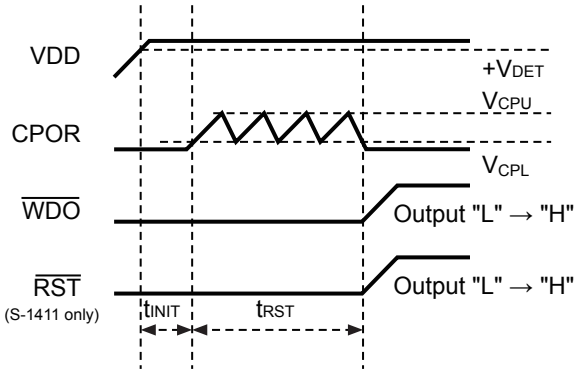


Figure 22 Test Circuit 15

■ Operation

1. From power-on to reset release

The S-1410/1411 Series initiates the initialization if the VDD pin voltage exceeds the release voltage ($+V_{DET}$).
The charge-discharge operation to the CPOR pin is initiated after the passage of the initialization time (t_{INIT}), and the $\overline{WDO}$ pin output and the $\overline{RST}$ pin output change from "L" to "H" after the operation is performed 4 times.



Remark V_{CPU}: CPOR charge upper limit threshold (1.25 V typ.)
V_{CPL}: CPOR charge lower limit threshold (0.20 V typ.)

Figure 23

t_{INIT} changes according to the power supply rising time. Refer to **Figure 24** for the relation between t_{INIT} and the power supply rising time.

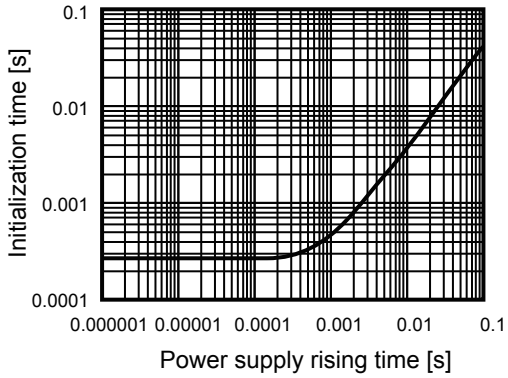
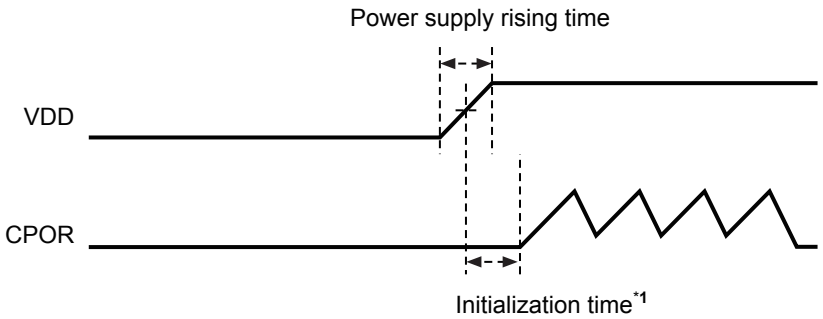


Figure 24 Power Supply Rising Time Dependency of Initialization Time



***1.** The initialization time is the time period from when the VDD pin voltage reaches V_{DD} / 2 to when C_{POR} rises.

Figure 25 Initialization Time

2. From reset release to initiation of charge-discharge operation to CWDT pin

The charge-discharge operation to the CWDT pin differs depending on the status of the WEN pin at the reset release.

2. 1 When WEN pin is "H" at reset release (Active "H")

Since the watchdog timer is Enable, the S-1410/1411 Series initiates the charge-discharge operation to the CWDT pin.

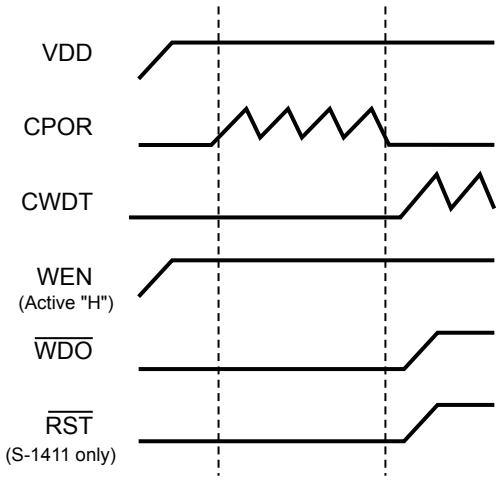


Figure 26 WEN Pin = "H"

2. 2 When WEN pin is "L" at reset release (Active "H")

Since the watchdog timer is Disable after the CPOR pin performs the charge-discharge operation 4 times, the S-1410/1411 Series does not initiate the charge-discharge operation to the CWDT pin. If the input to the WEN pin changes to "H" in this status, the S-1410/1411 Series initiates the charge-discharge operation to the CWDT pin.

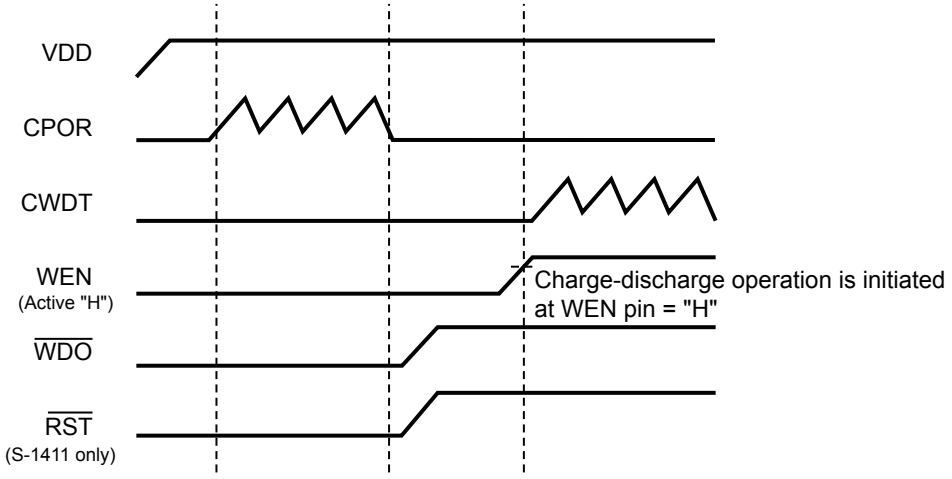


Figure 27 WEN Pin = "L" → "H"

3. Watchdog time-out detection

The watchdog timer detects a time-out after the charge-discharge operation to the CWDT pin is performed 32 times, then the $\overline{WDO}$ pin output changes from "H" to "L".

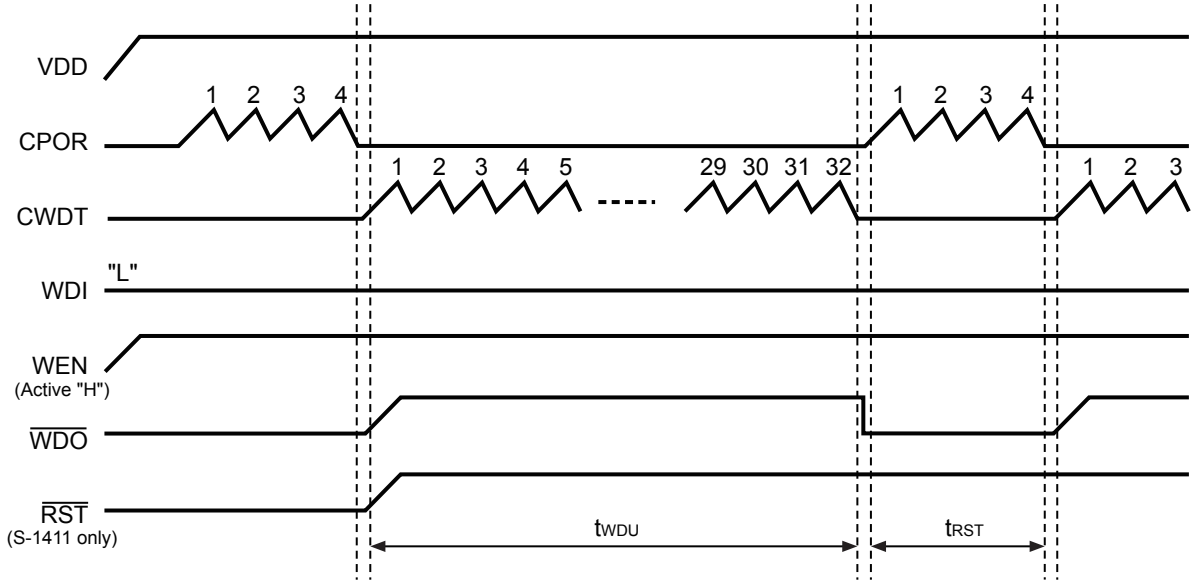


Figure 28

4. Internal counter reset due to edge detection

When the WDI pin detects an edge during the charge-discharge operation to the CWDT pin, the internal counter which counts the number of times of the charge-discharge operation is reset. The CWDT pin initiates the discharge operation when an edge is detected, and initiates the charge-discharge operation again after the discharge operation is completed.

4. 1 Counter reset due to rising edge detection (S-141xAxx, S-141xDxx, S-141xGxx, S-141xJxx)

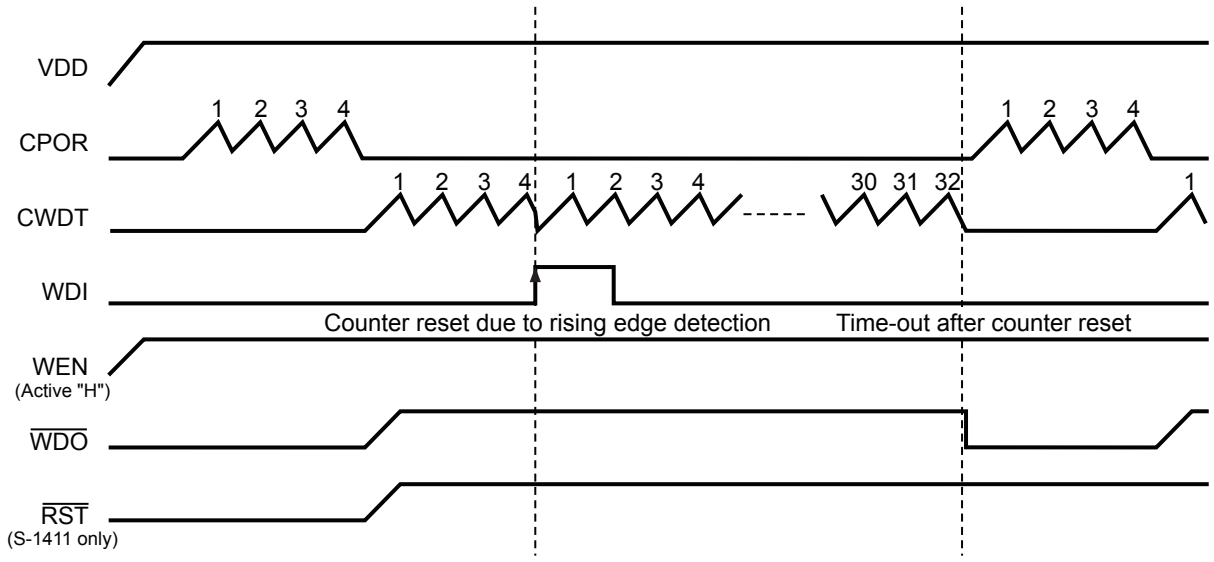


Figure 29

4. 2 Counter reset due to falling edge detection (S-141xBxx, S-141xExx, S-141xHxx, S-141xKxx)

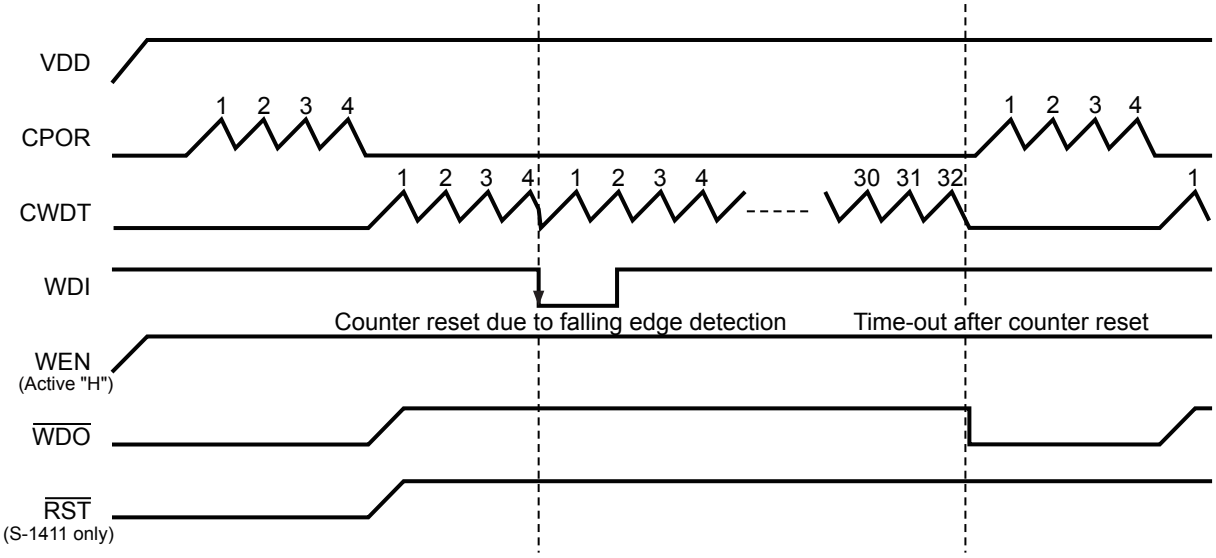


Figure 30

4. 3 Counter reset due to both rising and falling edges detection 1 (S-141xCxx, S-141xFxx, S-141xIxx, S-141xLxx)

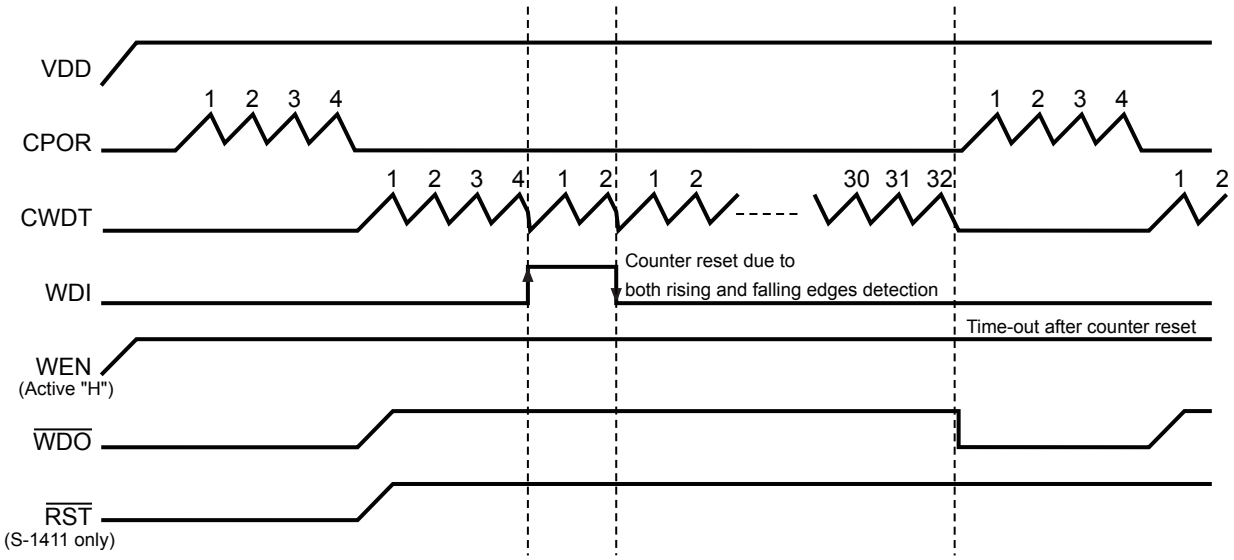


Figure 31

4. 4 Counter reset due to both rising and falling edges detection 2 (S-141xCxx, S-141xFxx, S-141xIxx, S-141xLxx)

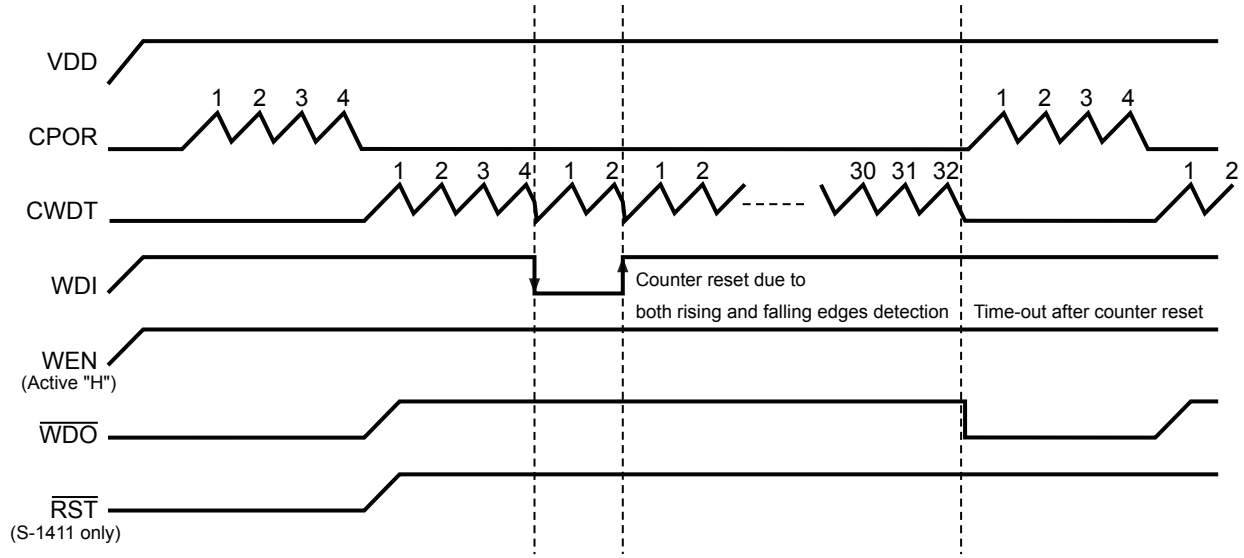


Figure 32

5. WEN pin operation during charge-discharge operation to CWDT pin

When the WEN pin changes from "H" to "L" during the charge-discharge operation to the CWDT pin, the CWDT pin performs the discharge operation. Moreover, the internal counter which counts the number of times of the charge-discharge operation for the CWDT pin is also reset.
If the WEN pin changes to "H" again in this status, the CWDT pin initiates the charge-discharge operation.

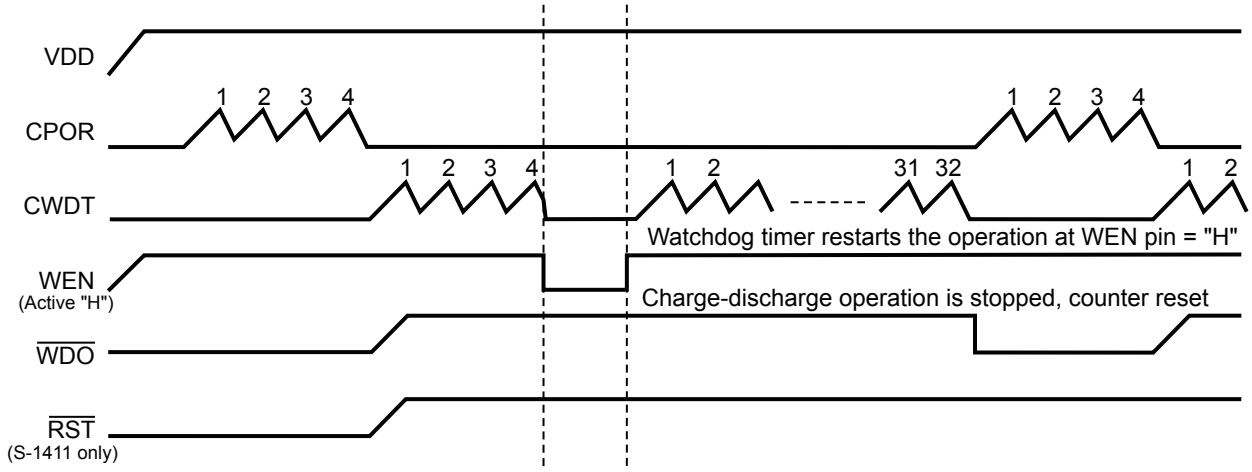


Figure 33

6. Watchdog double pulse detection

If an edge is input to the WDI pin again within a specific period of time (the discharge time due to an edge detection + 1 charge-discharge time (t_{WDL})) after inputting an edge to the WDI pin when the S-1410/1411 Series is the window mode, the $\overline{WDO}$ pin output changes from "H" to "L".
When the watchdog timer becomes Disable due to a change of the WEN pin ("H" → "L" → "H") after inputting an edge to the WDI pin, the $\overline{WDO}$ pin continues outputting "H" even if an edge is input to the WDI pin within the specific period of time mentioned above.

6. 1 Double pulse detection due to rising edge detection (S-141xAxx, S-141xDxx, S-141xGxx, S-141xJxx)

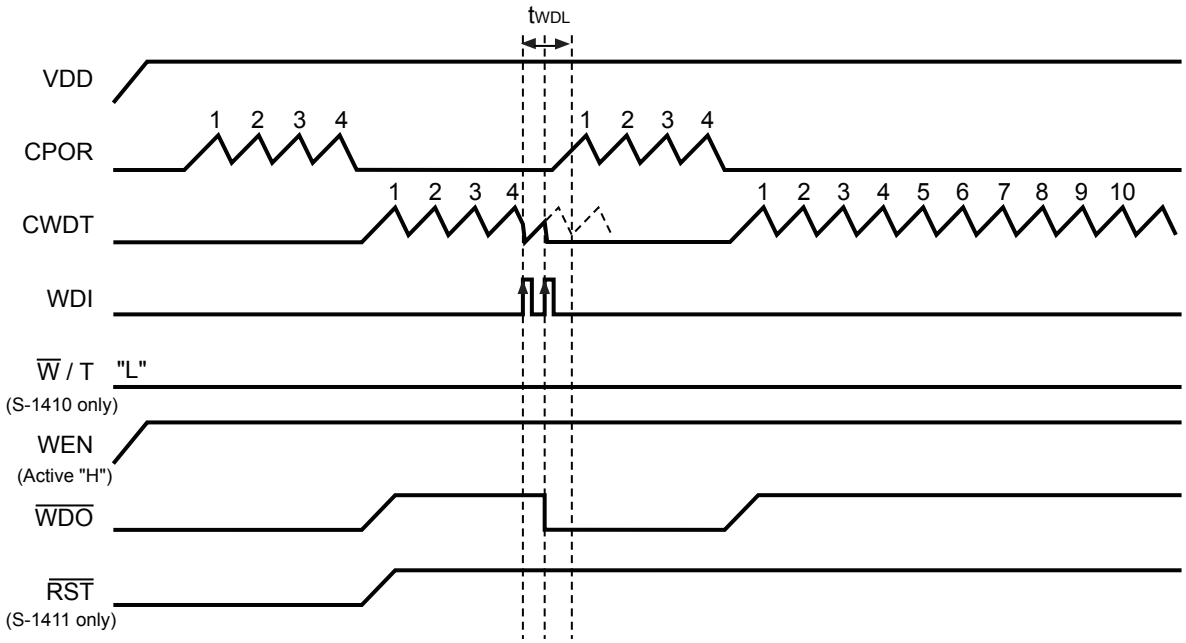


Figure 34

6. 2 Double pulse detection due to falling edge detection (S-141xBxx, S-141xExx, S-141xHxx, S-141xKxx)

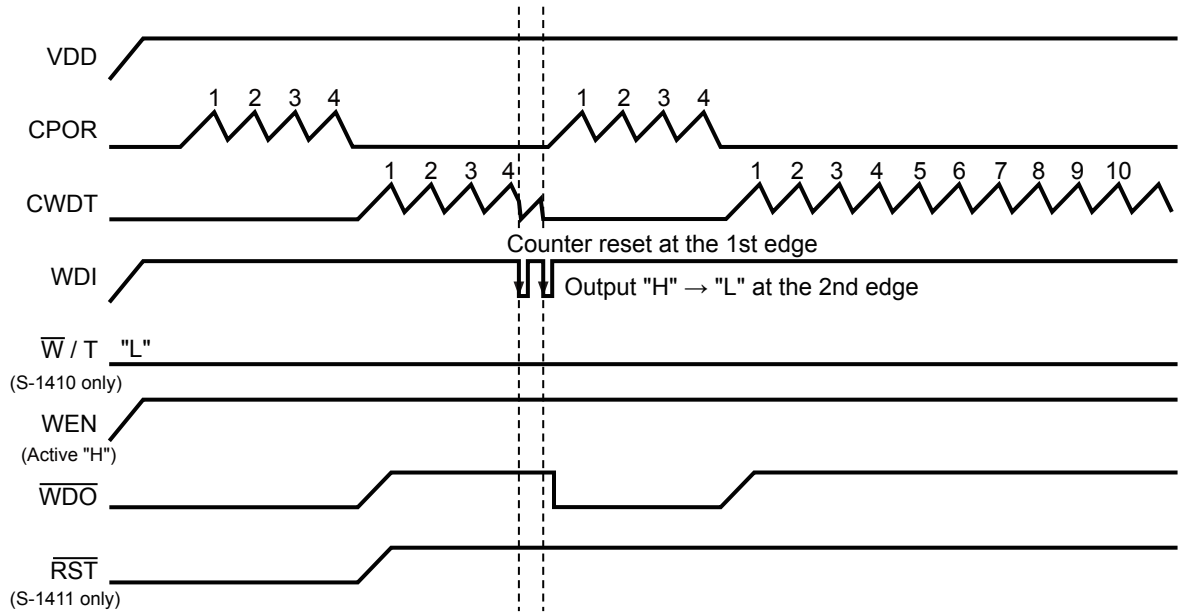


Figure 35

6. 3 Double pulse detection due to both rising and falling edges detection (S-141xCxx, S-141xFxx, S-141xIxx, S-141xLxx)

The double pulse is detected only when edges are input in order of rising and falling.

6. 3. 1 When edges are input to WDI pin in order of rising and falling

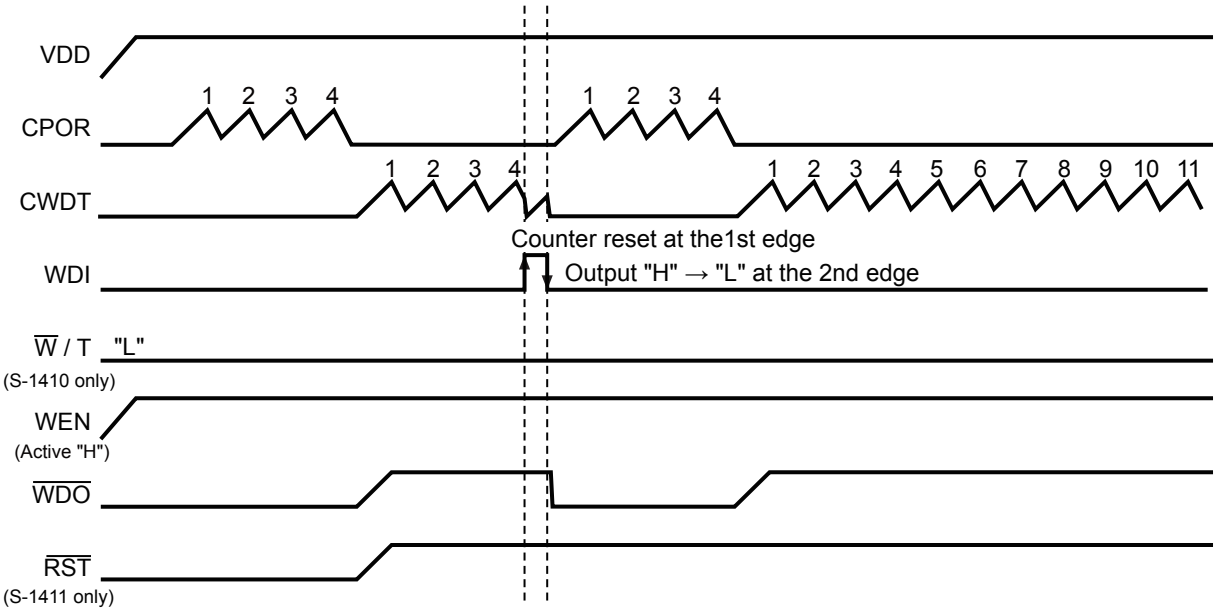


Figure 36 Double Pulse Detection

6. 3. 2 When edges are input to WDI pin in order of falling and rising

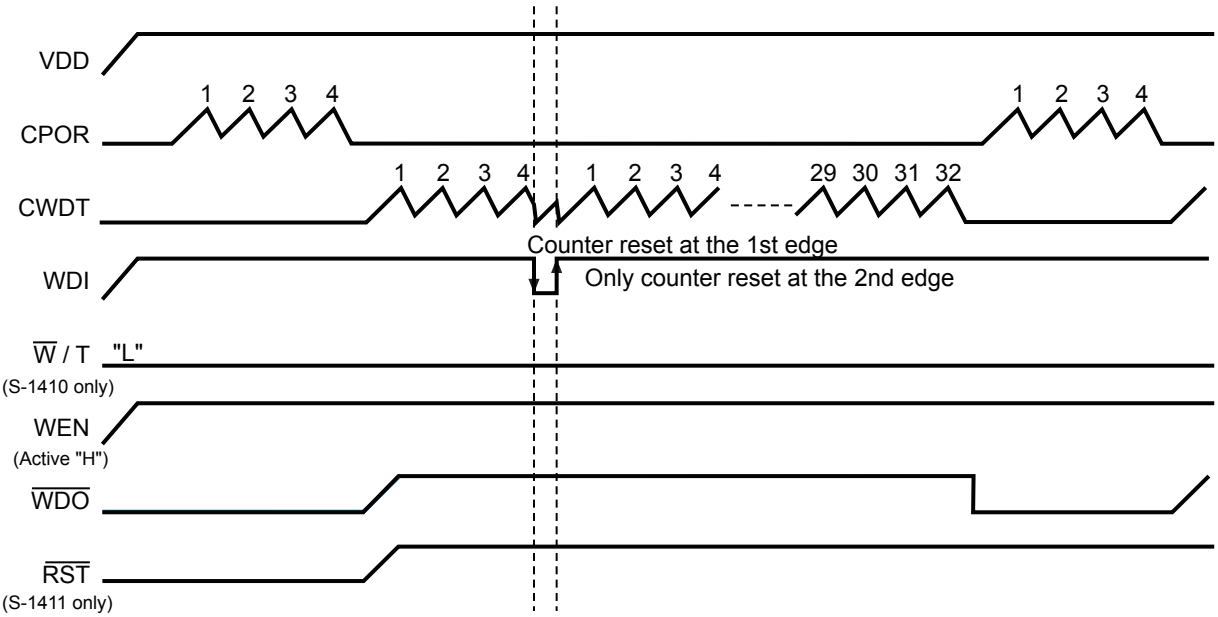


Figure 37 Double Pulse Non-detection

7. Operation of low voltage detection

The voltage detection circuit detects a low voltage if the power supply voltage falls below the detection voltage, and then "L" is output from the $\overline{\text{WDO}}$ pin and the $\overline{\text{RST}}$ pin (Only the S-1411 Series). The output is maintained until the charge-discharge operation of the CPOR pin is performed 4 times.
The S-1410/1411 Series can detect a low voltage even if either the CPOR pin or the WDT pin performs the charge-discharge operation. In this case, the status of the WEN pin or the $\overline{\text{W}}$ / T pin does not have an affect.

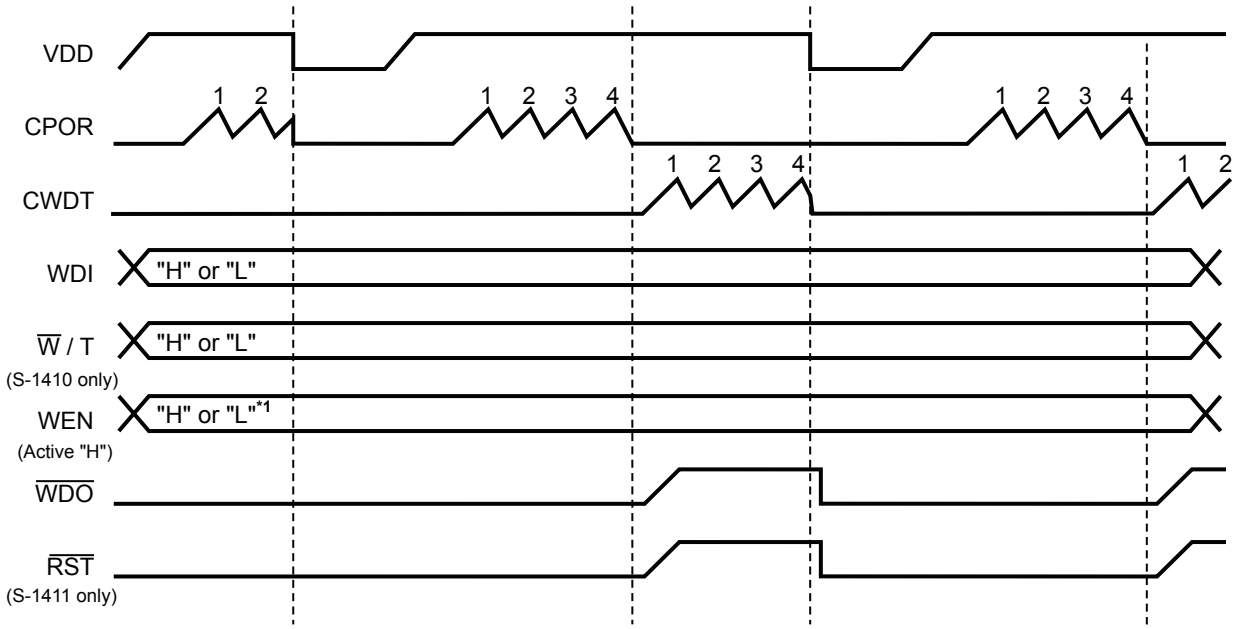


Figure 38

***1.** When the WEN pin is Disable, the charge-discharge operation of CWDT pin is not performed.

8. WEN pin, WDI pin and $\overline{\text{W}}$ / T pin

Each of the WEN pin, the WDI pin and the $\overline{\text{W}}$ / T pin has a noise filter.
If the power supply voltage is 5.0 V, noise with a minimum pulse width of 200 ns can be eliminated.

■ Standard Circuits

1. S-1410 Series (Product with $\overline{W}$ / T pin)

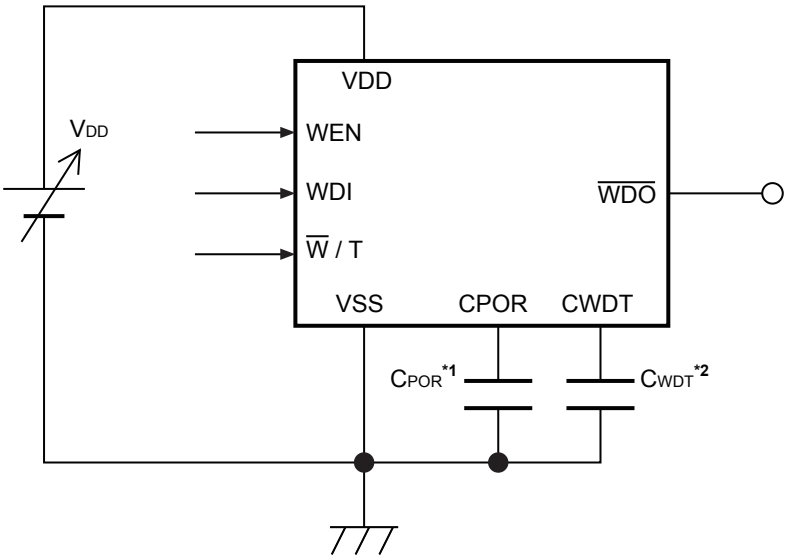


Figure 39

2. S-1411 Series (Product without $\overline{W}$ / T pin)

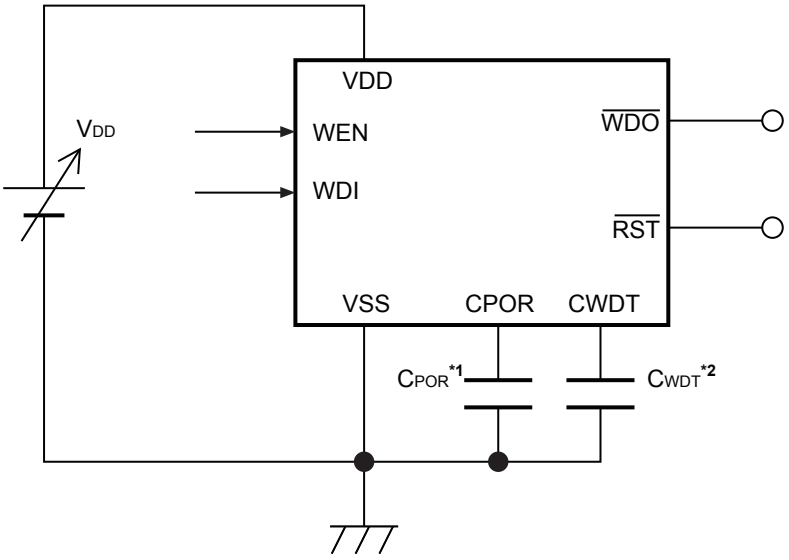


Figure 40

***1.** Adjustment capacitor for reset output delay time (C_{POR}) should be connected directly to the CPOR pin and the VSS pin.

***2.** Adjustment capacitor for watchdog output delay time (C_{WDT}) should be connected directly to the CWDT pin and the VSS pin.
A capacitor of 100 pF to 1 μF can be used for C_{POR} and C_{WDT}.

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constants.

■ Precautions

- It will take time for the discharge operation to be performed if the capacitance of C_{POR} is extremely large at the low voltage detection, so the discharge operation may not be completed by the time the power supply voltage exceeds the detection voltage. In that case, since the charge-discharge operation of the CPOR pin is performed after the discharge operation is completed, the delay time of the same time length as the discharge operation occurs in reset time-out period (t_{RST}).

- Select a capacitor which satisfies the following equation for C_{POR} and C_{WDT}. If this condition is not satisfied, the delay time of the same time length as the discharge operation occurs in t_{RST} since the discharge operation of an external capacitor connected to the CWDT pin is not completed by the time the CWDT pin initiates the next charge-discharge operation.

$$C_{WDT} / C_{POR} \leq 600$$

- When the power supply voltage falls to 0.9 V or lower, set a time interval of 20 μs or longer by the time the power supply is raised again. If the appropriate time length is not secured, the time-out period after raising the power supply voltage may get delayed.

- When the time that the power supply voltage falls below the detection voltage is short, the S-1410/1411 Series may not detect a voltage. In that case, the time-out period after raising the power supply voltage may get delayed.

- Since input pins (the WEN pin, the WDI pin and the $\overline{W}$ / T pin) in the S-1410/1411 Series are CMOS configurations, make sure that an intermediate potential is not input when the S-1410/1411 Series operates.

- Since the $\overline{WDO}$ pin and the $\overline{RST}$ pin are affected by external resistance and external capacitance, use the S-1410/1411 Series after performing thorough evaluation with the actual application.

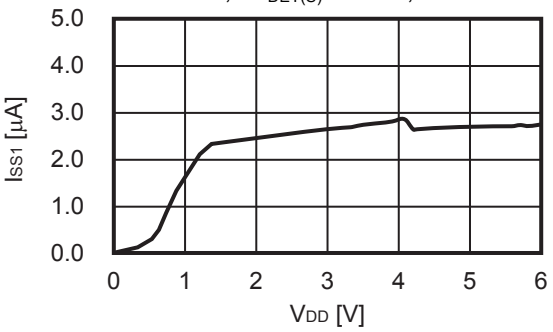
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.

- SII Semiconductor Corporation claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

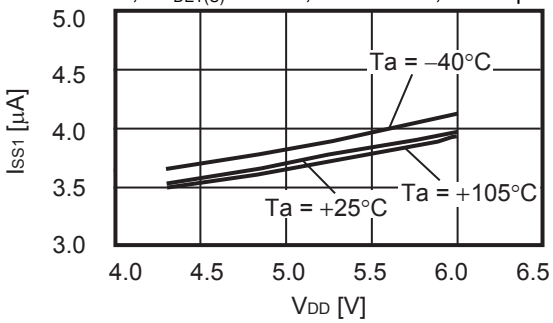
■ Characteristics (Typical Data)

1. Current consumption during operation (I_{SS1}) vs. Input voltage (V_{DD})

WDT = OFF, $-V_{DET(S)}$ = 4.0 V, Ta = +25°C

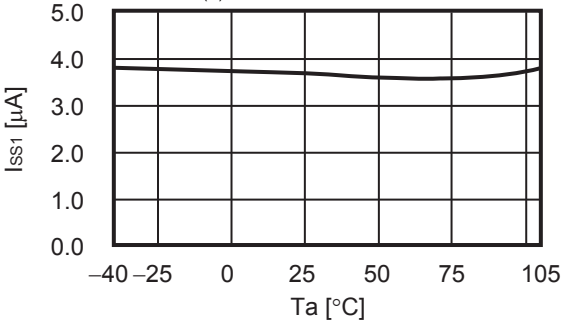


WDT = ON, $-V_{DET(S)}$ = 4.0 V, Ta = +25°C, WDI input



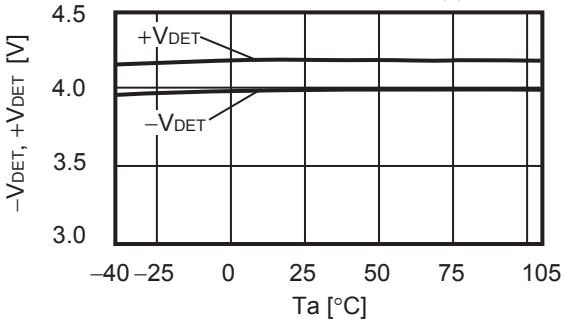
2. Current consumption during operation (I_{SS1}) vs. Temperature (Ta)

WDT = ON, $-V_{DET(S)}$ = 4.0 V, V_{DD} = 5.0 V, WDI input



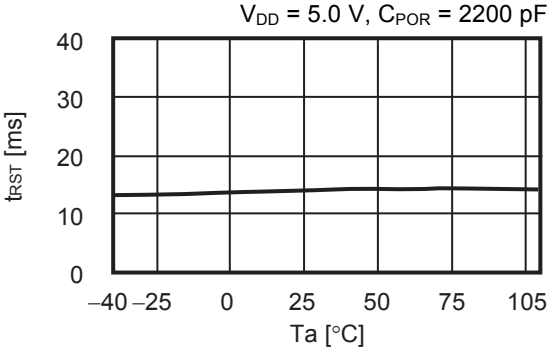
3. Detection voltage ($-V_{DET}$), Release voltage ($+V_{DET}$) vs. Temperature (Ta)

$-V_{DET(S)}$ = 4.0 V



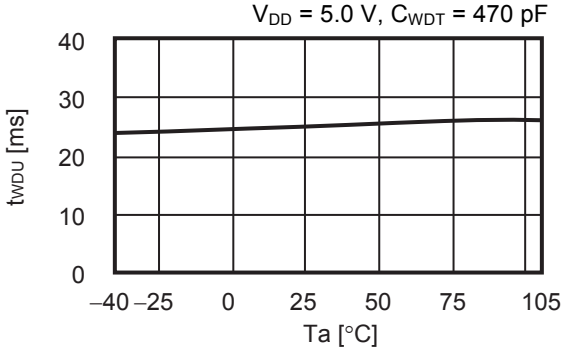
4. Reset time-out period (t_{RST}) vs. Temperature (Ta)

V_{DD} = 5.0 V, C_{POR} = 2200 pF



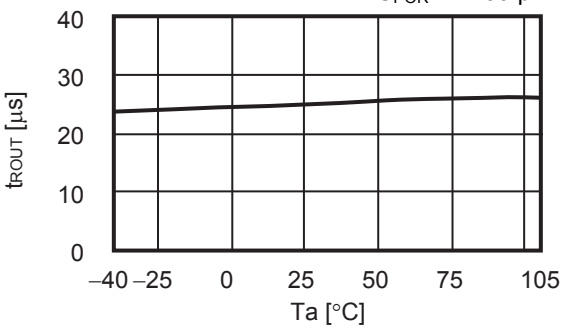
5. Watchdog time-out period (t_{WDU}) vs. Temperature (Ta)

V_{DD} = 5.0 V, C_{WDT} = 470 pF



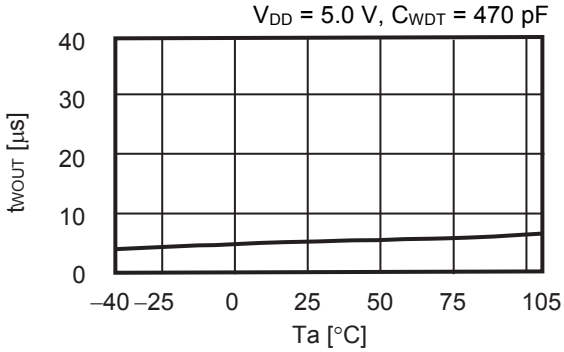
6. Reset output delay time (t_{ROUT}) vs. Temperature (Ta)

V_{DD} = $-V_{DET(S)}$ + 1.0 V → $-V_{DET(S)}$ − 1.0 V,
C_{POR} = 2200 pF

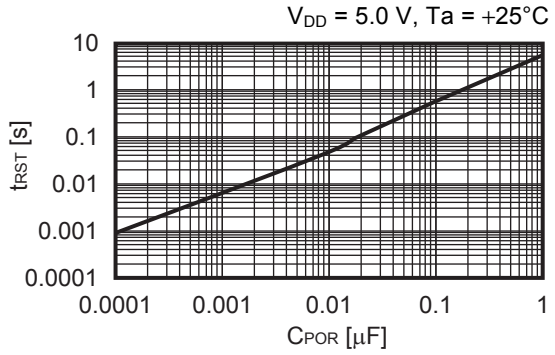


7. Watchdog output delay time (t_{WOUT}) vs. Temperature (Ta)

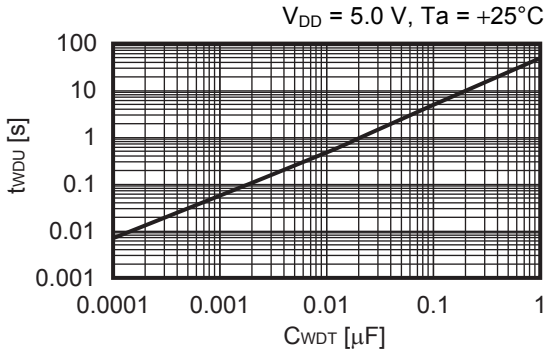
V_{DD} = 5.0 V, C_{WDT} = 470 pF



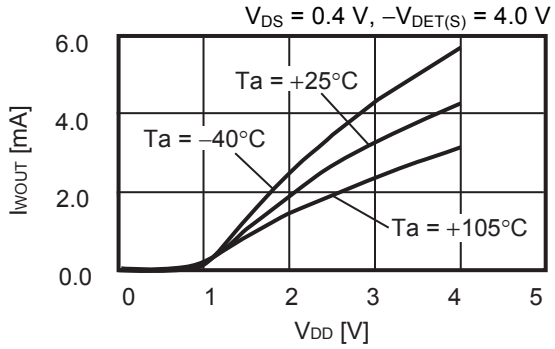
8. Reset time-out period (t_{RST}) vs. C_{POR}



9. Watchdog time-out period (t_{WDU}) vs. C_{WDT}



10. Nch driver output current (I_{WOUT}) vs. Input voltage (V_{DD})



■ Thermal Characteristics

1. TMSOP-8

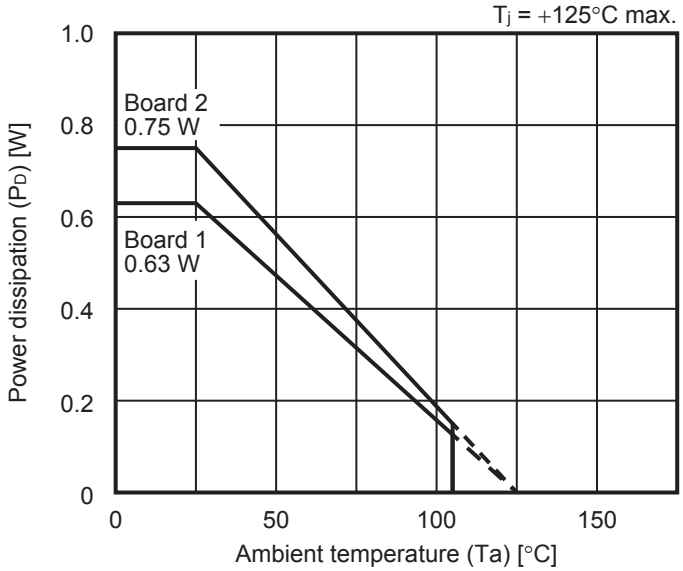


Figure 41 Power Dissipation of Package (When Mounted on Board)

1. 1 Board 1

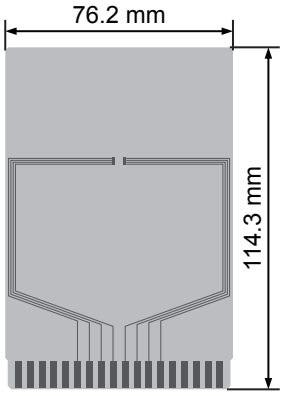


Figure 42

Table 10

Item		Specification
Thermal resistance value (θ_{ja})		160°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		2
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	–
	3	–
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–

1. 2 Board 2

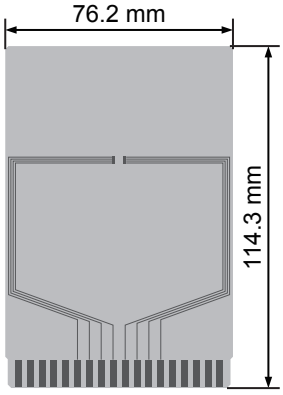


Figure 43

Table 11

Item		Specification
Thermal resistance value (θ_{ja})		133°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		4
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	74.2 mm × 74.2 mm × t0.035 mm
	3	74.2 mm × 74.2 mm × t0.035 mm
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–

2. HSNT-8(2030)

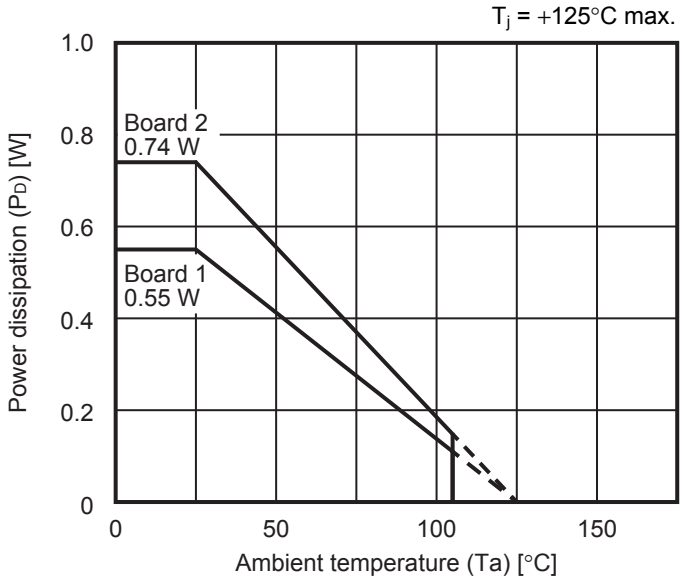


Figure 44 Power Dissipation of Package (When Mounted on Board)

2. 1 Board 1

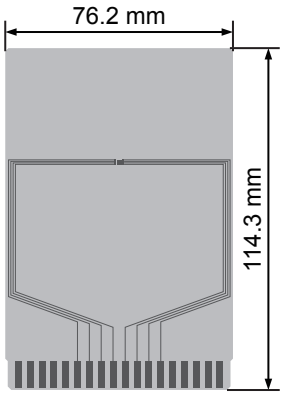


Figure 45

Table 12

Item		Specification
Thermal resistance value (θ_{ja})		181°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		2
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	–
	3	–
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–

2. 2 Board 2

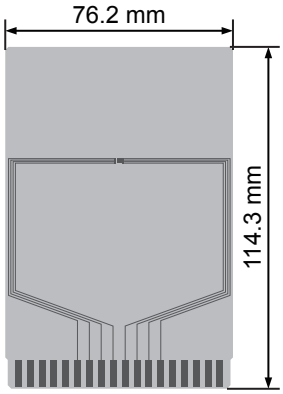
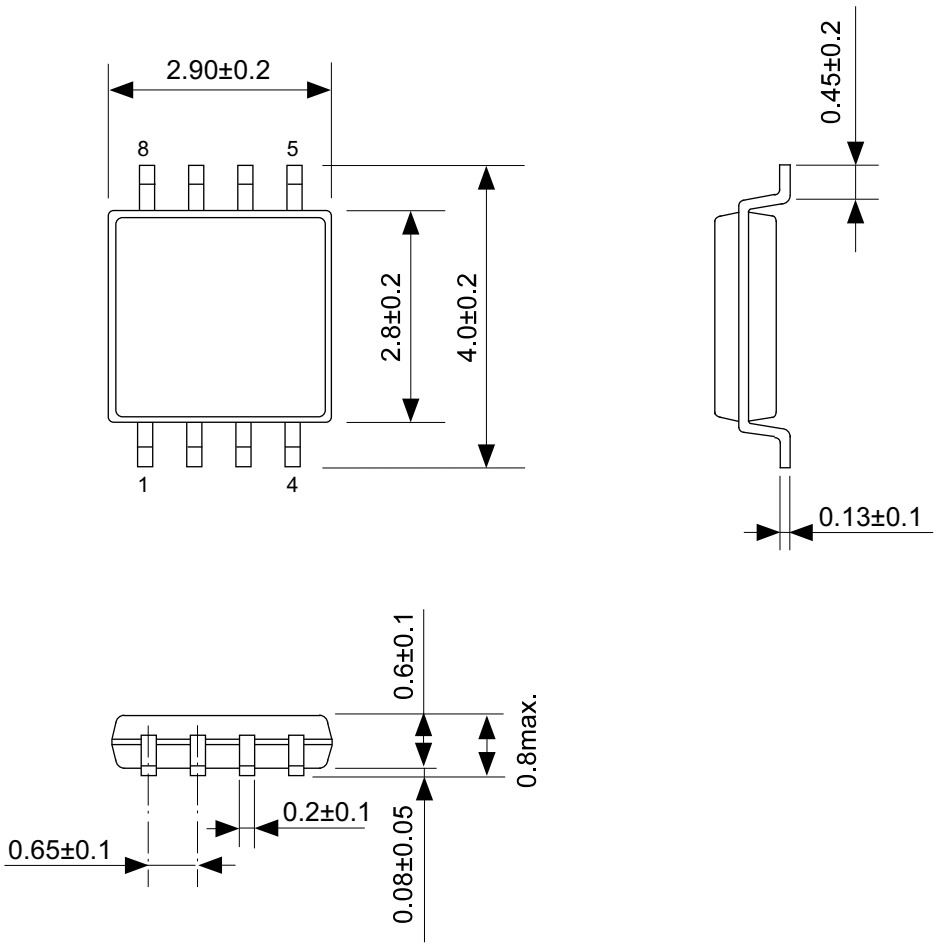


Figure 46

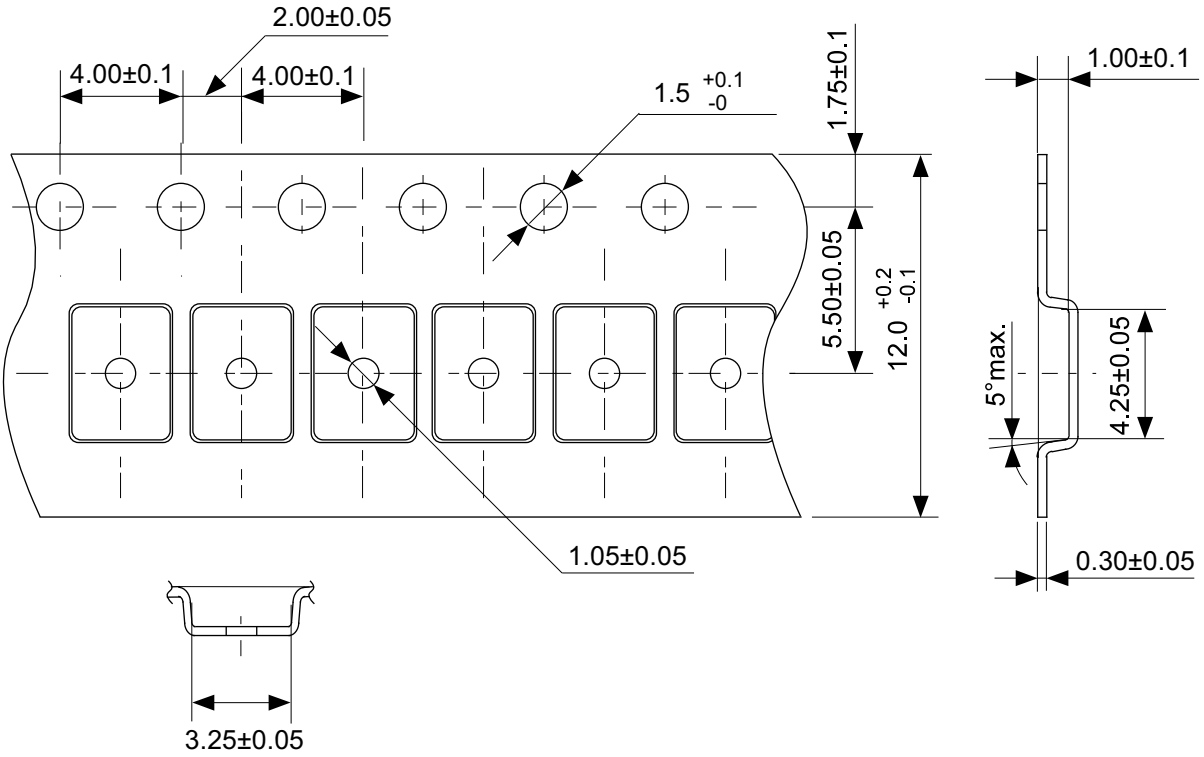
Table 13

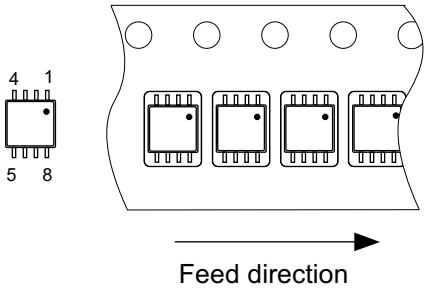
Item		Specification
Thermal resistance value (θ_{ja})		135°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		4
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	74.2 mm × 74.2 mm × t0.035 mm
	3	74.2 mm × 74.2 mm × t0.035 mm
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–



No. FM008-A-P-SD-1.2

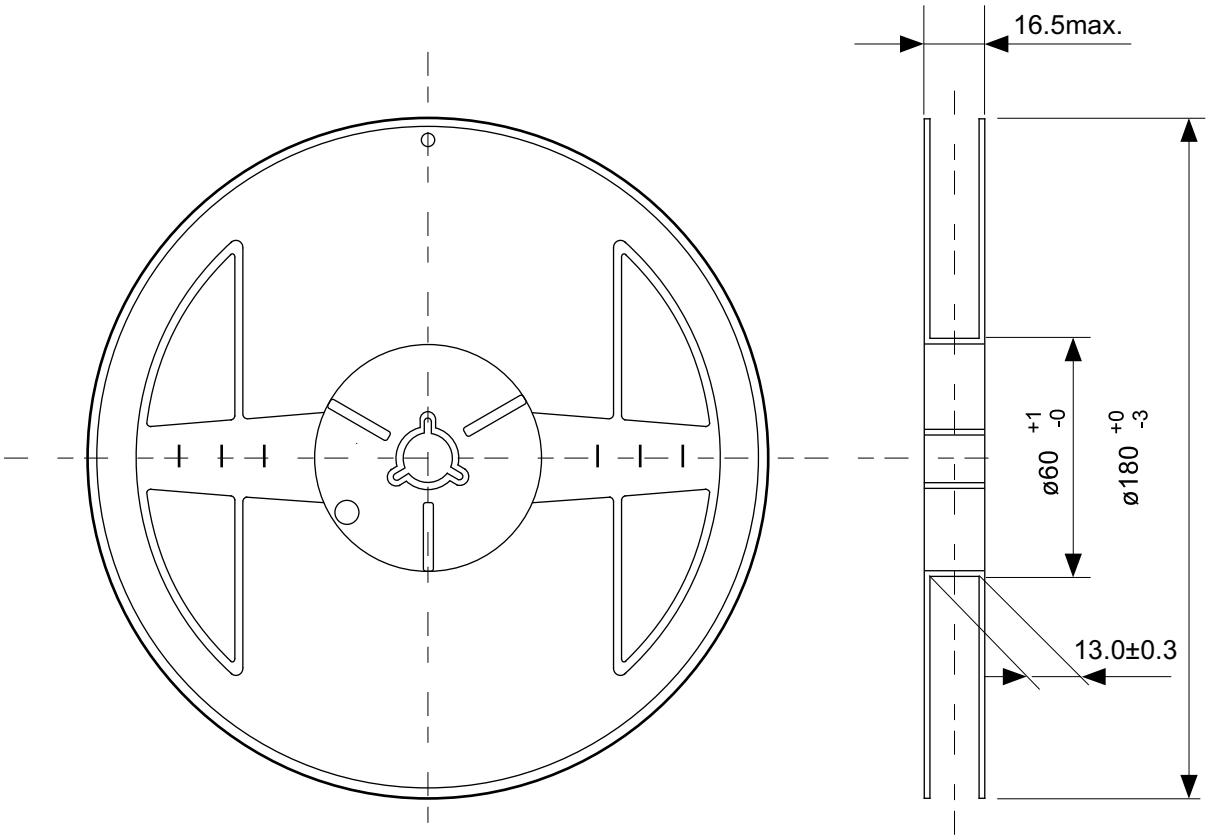
TITLE	TMSOP8-A-PKG Dimensions
No.	FM008-A-P-SD-1.2
ANGLE	
UNIT	mm
SII Semiconductor Corporation	



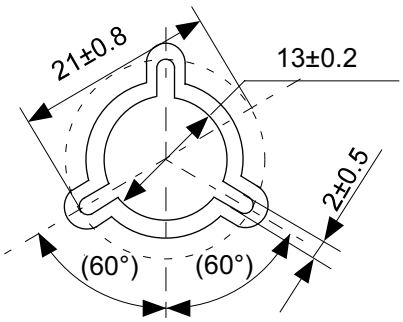


No. FM008-A-C-SD-2.0

TITLE	TMSOP8-A-Carrier Tape
No.	FM008-A-C-SD-2.0
ANGLE	
UNIT	mm
SII Semiconductor Corporation	

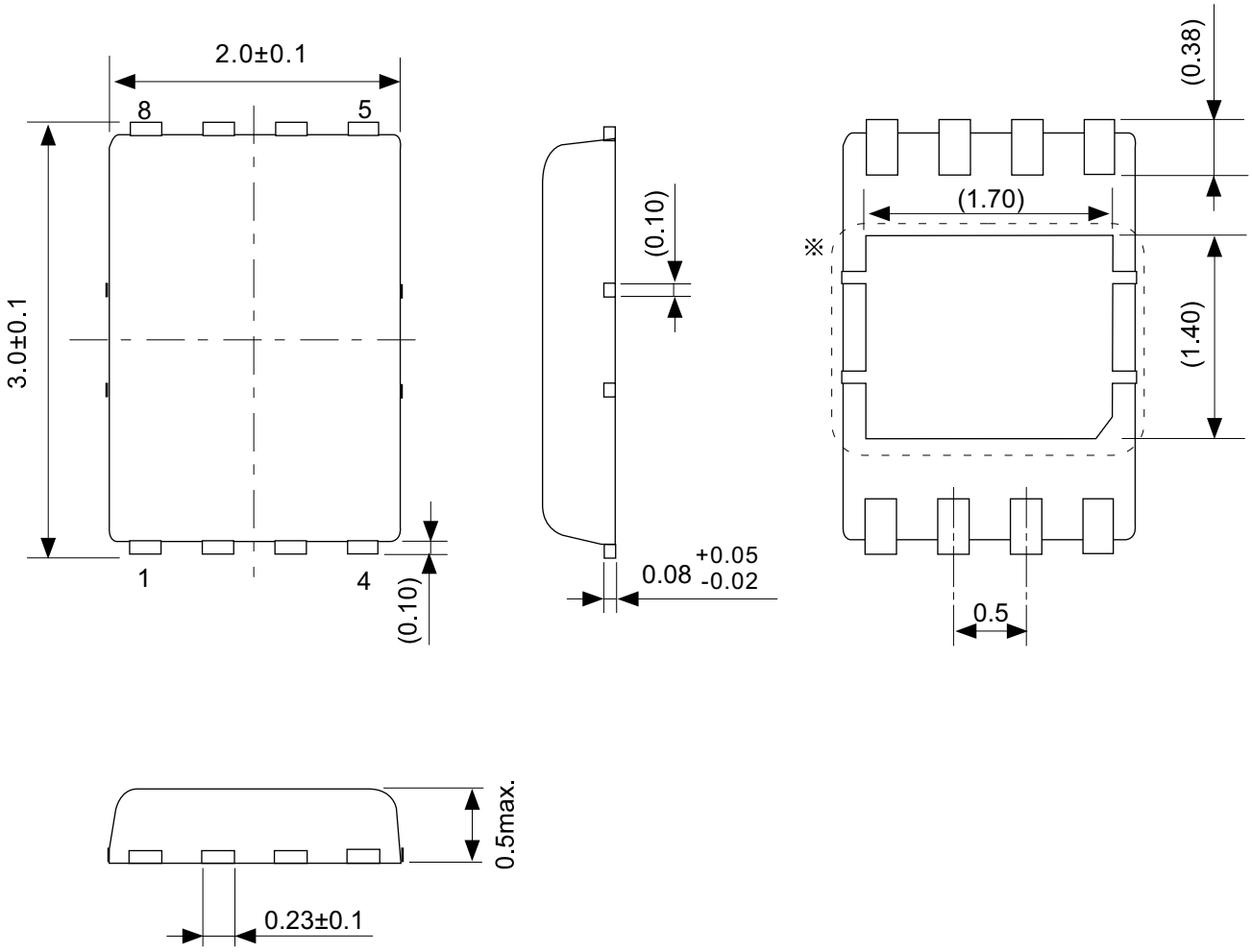


Enlarged drawing in the central part



No. FM008-A-R-SD-1.0

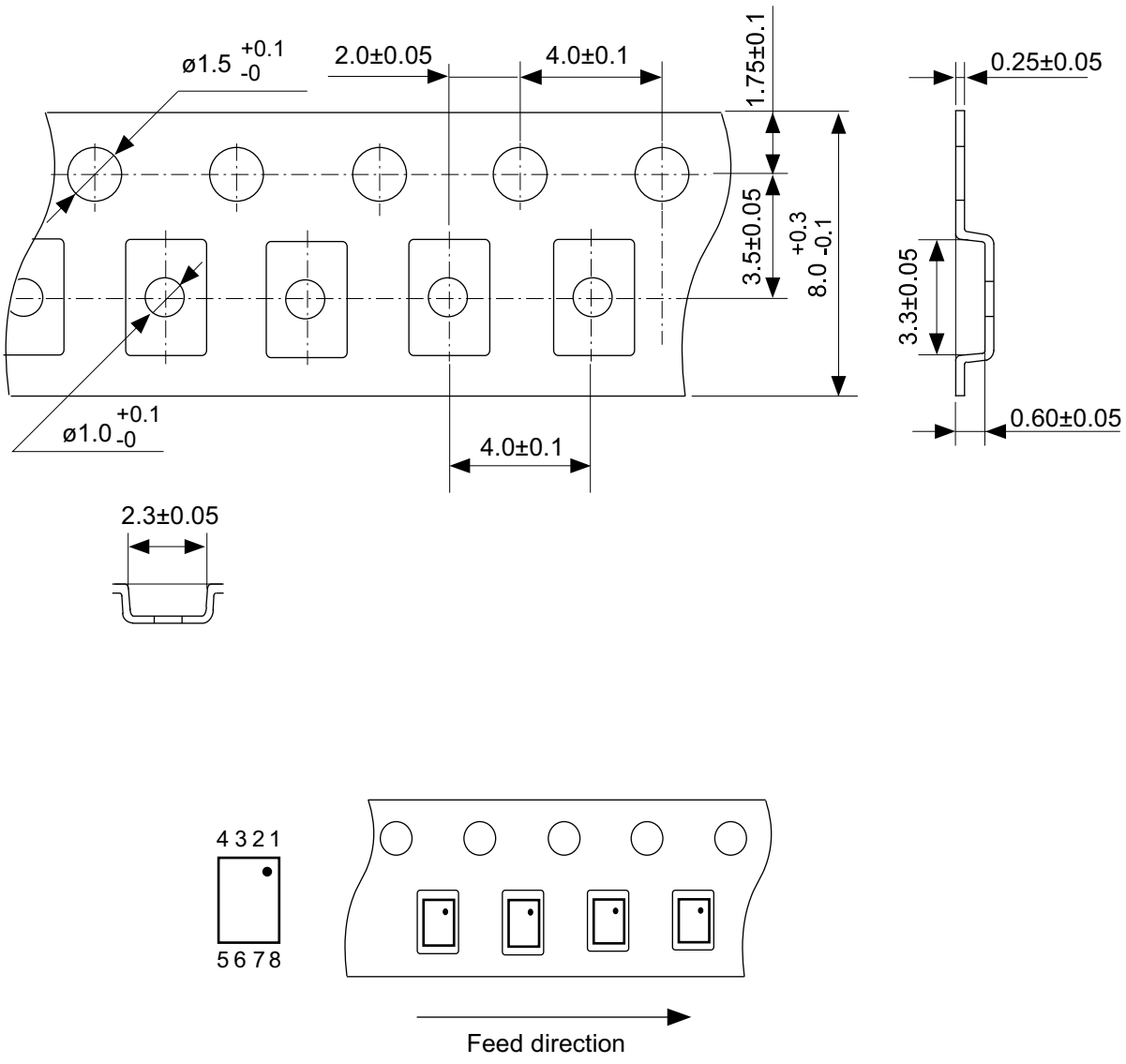
TITLE	TMSOP8-A-Reel		
No.	FM008-A-R-SD-1.0		
ANGLE		QTY.	4,000
UNIT	mm		
SII Semiconductor Corporation			



No. PP008-A-P-SD-2.0

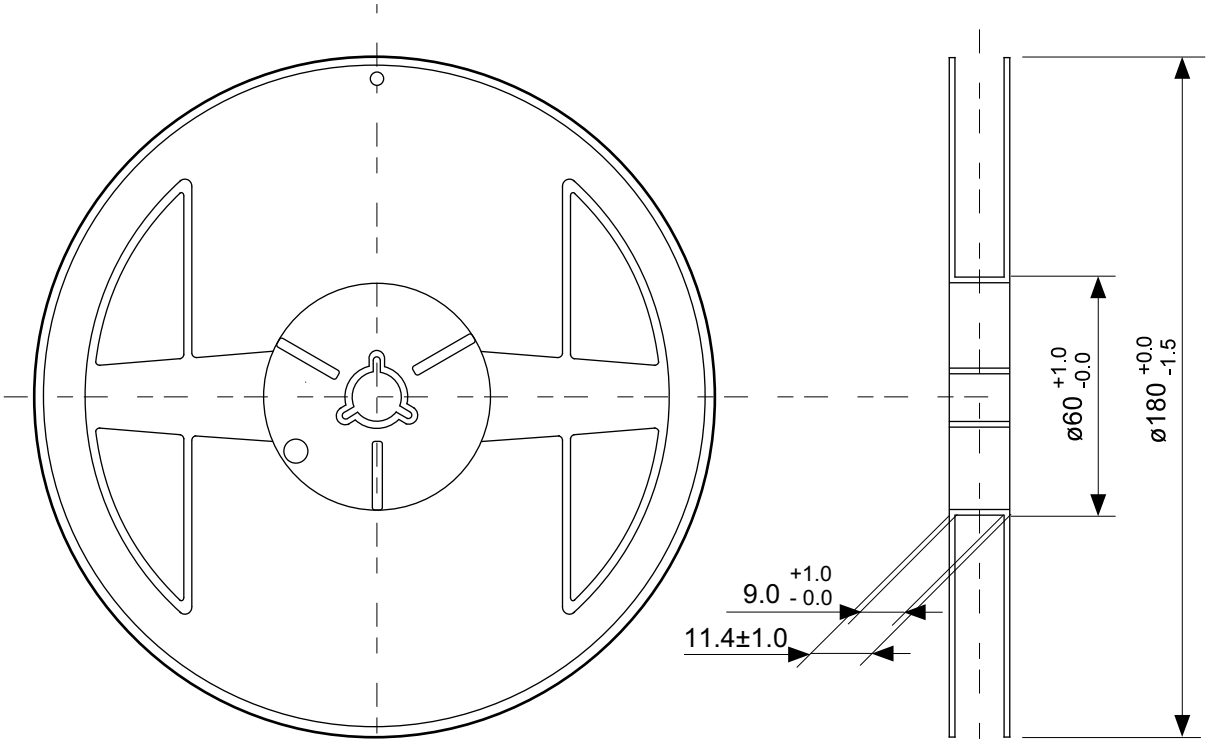
※ The heat sink of back side has different electric potential depending on the product.
Confirm specifications of each product.
Do not use it as the function of electrode.

TITLE	DFN-8/HSNT-8-A-PKG Dimensions
No.	PP008-A-P-SD-2.0
ANGLE	
UNIT	mm
SII Semiconductor Corporation	

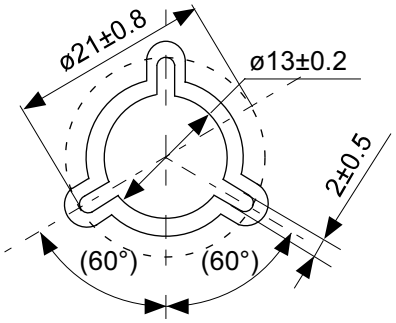


No. PP008-A-C-SD-1.0

TITLE	DFN-8/HSNT-8-A-Carrier Tape
No.	PP008-A-C-SD-1.0
ANGLE	
UNIT	mm
SII Semiconductor Corporation	

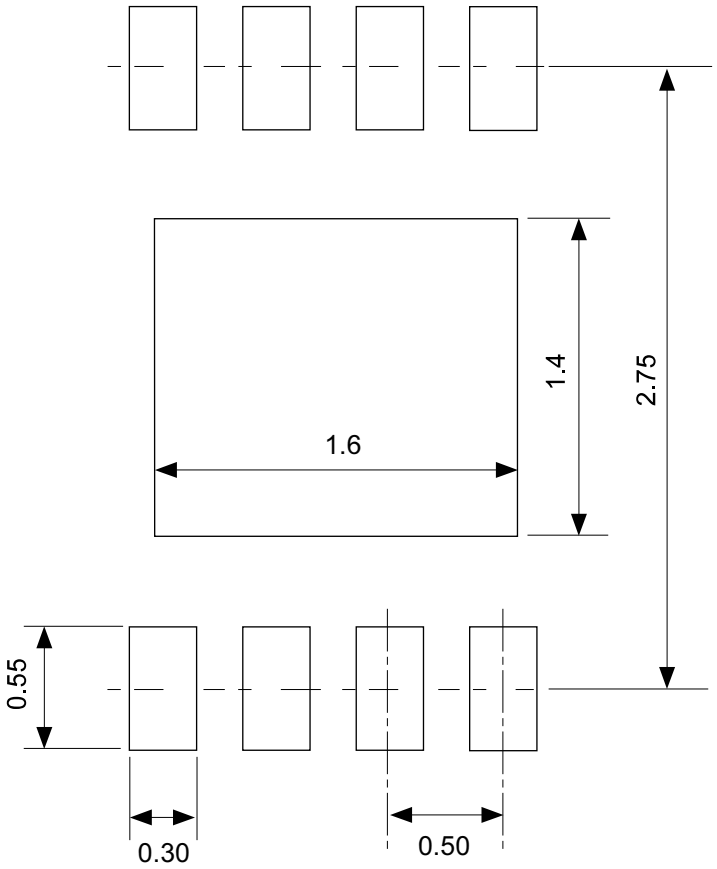


Enlarged drawing in the central part



No. PP008-A-R-SD-1.0

TITLE	DFN-8/HSNT-8-A-Reel		
No.	PP008-A-R-SD-1.0		
ANGLE		QTY.	5,000
UNIT	mm		
SII Semiconductor Corporation			



No. PP008-A-L-SD-1.0

TITLE	DFN-8/HSNT-8-A -Land Recommendation
No.	PP008-A-L-SD-1.0
ANGLE	
UNIT	mm
SII Semiconductor Corporation	

Disclaimers (Handling Precautions)

1. All the information described herein (product data, specifications, figures, tables, programs, algorithms and application circuit examples, etc.) is current as of publishing date of this document and is subject to change without notice.
2. The circuit examples and the usages described herein are for reference only, and do not guarantee the success of any specific mass-production design.
   SII Semiconductor Corporation is not responsible for damages caused by the reasons other than the products or infringement of third-party intellectual property rights and any other rights due to the use of the information described herein.
3. SII Semiconductor Corporation is not responsible for damages caused by the incorrect information described herein.
4. Take care to use the products described herein within their specified ranges. Pay special attention to the absolute maximum ratings, operation voltage range and electrical characteristics, etc.
   SII Semiconductor Corporation is not responsible for damages caused by failures and/or accidents, etc. that occur due to the use of products outside their specified ranges.
5. When using the products described herein, confirm their applications, and the laws and regulations of the region or country where they are used and verify suitability, safety and other factors for the intended use.
6. When exporting the products described herein, comply with the Foreign Exchange and Foreign Trade Act and all other export-related laws, and follow the required procedures.
7. The products described herein must not be used or provided (exported) for the purposes of the development of weapons of mass destruction or military use. SII Semiconductor Corporation is not responsible for any provision (export) to those whose purpose is to develop, manufacture, use or store nuclear, biological or chemical weapons, missiles, or other military use.
8. The products described herein are not designed to be used as part of any device or equipment that may affect the human body, human life, or assets (such as medical equipment, disaster prevention systems, security systems, combustion control systems, infrastructure control systems, vehicle equipment, traffic systems, in-vehicle equipment, aviation equipment, aerospace equipment, and nuclear-related equipment), excluding when specified for in-vehicle use or other uses. Do not use those products without the prior written permission of SII Semiconductor Corporation.
   Especially, the products described herein cannot be used for life support devices, devices implanted in the human body and devices that directly affect human life, etc.
   Prior consultation with our sales office is required when considering the above uses.
   SII Semiconductor Corporation is not responsible for damages caused by unauthorized or unspecified use of our products.
9. Semiconductor products may fail or malfunction with some probability.
   The user of these products should therefore take responsibility to give thorough consideration to safety design including redundancy, fire spread prevention measures, and malfunction prevention to prevent accidents causing injury or death, fires and social damage, etc. that may ensue from the products' failure or malfunction.
   The entire system must be sufficiently evaluated and applied on customer's own responsibility.
10. The products described herein are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
11. The products described herein do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Take care when handling these with the bare hands to prevent injuries, etc.
12. When disposing of the products described herein, comply with the laws and ordinances of the country or region where they are used.
13. The information described herein contains copyright information and know-how of SII Semiconductor Corporation.
    The information described herein does not convey any license under any intellectual property rights or any other rights belonging to SII Semiconductor Corporation or a third party. Reproduction or copying of the information described herein for the purpose of disclosing it to a third-party without the express permission of SII Semiconductor Corporation is strictly prohibited.
14. For more details on the information described herein, contact our sales office.

1.0-2016.01